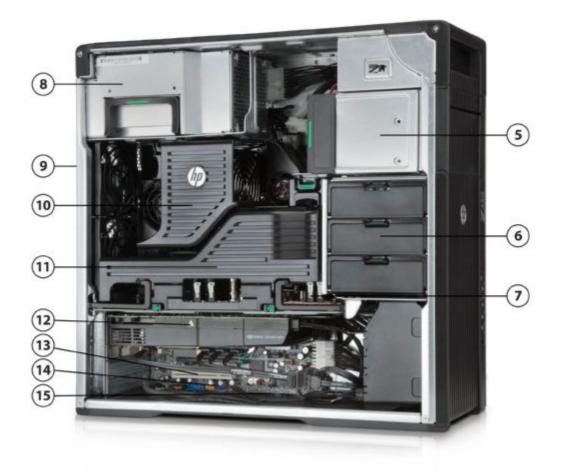


- 1. 2 External 5.25" Bays (shown with optional slot-load optical drive)
- 2. Power Button
- 3. HDD Activity LED
- 4. Front I/O: 1 USB 2.0, 2 USB 3.0, 1 Headphone, 1 Microphone, 1 1394a



- 5. 2 External 5.25" Bays
- 6. 3 Internal 3.5" Bays
- 12 DIMM Slots for DDR3 ECC Memory 7.
- 8. 800W, 90% Efficient Power Supply
- 9. Rear I/O: Rear Power Button & LED, PS/2 Ports, 1 1394a, 415. 10 SATA Ports USB 2.0, 2 USB 3.0, 2 RJ-45 to Integrated GbE, 1 Audio Line In, 1 Audio Line Out, 1 Microphone
- 10. Intel Xeon Processors E5-1600 family or E5-2600 family

- 11. 2nd CPU & Memory Module
- 12. 2 PCle x16 Gen3 Slots
- 1 PCle x8 Gen3, 1 PCle x8(x4) Gen2, 1 PCle x4(x1) Gen2, 13. 1 PCI Slot
- 14. 6 Internal USB 2.0 Ports

Form Factor	Minitower
Operating Systems	Preinstalled:
	 Windows 7 Ultimate 64-bit* Windows 7 Professional 64-bit* Windows 7 Professional 32-bit* Windows 8.1 Pro 64-bit Windows 8.1 Simplified Chinese Edition 64-bit Windows 8.1 Pro Downgrade to Windows 7 Professional 32-bit



Overview

- Windows 8.1 Pro Downgrade to Windows 7 Professional 64-bit
- HP Installer Kit for Linux (includes drivers for 64-bit OS versions of RHEL 5 & 6 and SUSE Linux Enterprise Desktop 11)
- Red Hat Enterprise Linux Desktop (Preinstall NOT available; 1 year paper license only)

Supported:

- Genuine Windows® 7 Enterprise 32/64
- SUSE Linux Enterprise Desktop 11
- Windows® XP Professional 32/64 (on select configurations)*

Notes: *See the "Windows XP Support Matrix for Z Workstations" at: http://www.hp.com/support/workstation manuals

Notes: For detailed OS/hardware support information for Linux, see: http://www.hp.com/support/linux_hardware_matrix

Available Processors

E5-2643	Name	Cores	Clock Speed (GHz)	Cache (MB)	Memory Speed (MHz)	QPI Speed (GT/s)	Hyper- Threading	Featuring Intel® vPro™ Technology	Intel® Turbo Boost Technology ¹	TDP (W)
Intel Xeon	Intel Xeon									
Intel Xeon		4	3.3	10	1600	8.0	Y	Υ	1, 2	130
E5-2620 6 2.0 15 1333 7.2 Y Y 3,5 95 processor Intel Xeon E5-2697 v2 12 2.7 30 1866 8.0 Y Y 3,8 130 processor Intel Xeon E5-2695 v2 12 2.4 30 1866 8.0 Y Y Y 4,8 115 processor Intel Xeon E5-2690 v2 10 3.0 25 1866 8.0 Y Y Y 3,6 130 processor Intel Xeon E5-2690 v2 10 2.8 25 1866 8.0 Y Y Y 3,8 115 Intel Xeon E5-2680 v2 10 2.8 25 1866 8.0 Y Y Y 3,8 115 Intel Xeon E5-2670 v2 10 2.5 25 1866 8.0 Y Y Y 3,8 115 Intel Xeon E5-2670 v2 10 2.5 25 1866 8.0 Y Y Y 3,7 130 processor Intel Xeon E5-2670 v2 8 3.3 25 1866 8.0 Y Y Y 3,7 130 processor Intel Xeon E5-2660 v2 8 3.3 25 1866 8.0 Y Y Y 3,7 130 processor Intel Xeon E5-2650 v2 8 3.3 25 1866 8.0 Y Y Y 4,8 95 processor Intel Xeon E5-2650 v2 8 2.6 20 1866 8.0 Y Y Y 4,8 95 processor Intel Xeon E5-2650 v2 8 2.6 20 1866 8.0 Y Y Y 4,8 95 processor Intel Xeon E5-2643 v2 6 3.5 25 1866 8.0 Y Y Y 4,8 95	•	<u> </u>								
Intel Xeon										
Intel Xeon E5-2697 v2 12 2.7 30 1866 8.0 Y Y 3,8 130		6	2.0	15	1333	7.2	Y	Υ	3, 5	95
E5-2697 v2 processor 12 2.7 30 1866 8.0 Y Y 3,8 130 1810	•	<u> </u>								
Intel Xeon										
Intel Xeon E5-2695 v2		12	2.7	30	1866	8.0	Y	Υ	3, 8	130
E5-2695 v2 processor 12 2.4 30 1866 8.0 Y Y 4,8 115 Intel Xeon E5-2690 v2 processor 10 3.0 25 1866 8.0 Y Y 3,6 130 Intel Xeon E5-2680 v2 processor 10 2.8 25 1866 8.0 Y Y 3,8 115 Intel Xeon E5-2670 v2 processor 10 2.5 25 1866 8.0 Y Y 4,8 115 Intel Xeon E5-2670 v2 processor 10 2.5 25 1866 8.0 Y Y 4,8 115 Intel Xeon E5-2670 v2 8 3.3 25 1866 8.0 Y Y 3,7 130 E5-2670 v2 10 2.2 25 1866 8.0 Y Y 4,8 95 Intel Xeon E5-2660 v2 10 2.2 25 1866 8.0 Y Y 4,8 95 Intel Xeon E5-2650 v2 8 2.6 20 1866 8.0 Y Y 4,8 95 Intel Xeon E5-2650 v2 8 2.6 20 1866 8.0 Y Y 4,8 95 Intel Xeon E5-2643 v2 6 3.5 25 1866 8.0 Y Y 1,3 130	•									
Description										
Intel Xeon E5-2690 v2 10 3.0 25 1866 8.0 Y Y 3,6 130 130 130 130 140 1		12	2.4	30	1866	8.0	Y	Y	4, 8	115
E5-2690 v2	processor									
Description	Intel Xeon									
Intel Xeon E5-2680 v2 10 2.8 25 1866 8.0 Y Y 3,8 115 Intel Xeon E5-2670 v2 10 2.5 25 1866 8.0 Y Y 4,8 115 Intel Xeon E5-2667 v2 8 3.3 25 1866 8.0 Y Y Y 3,7 130 Intel Xeon E5-2667 v2 8 3.3 25 1866 8.0 Y Y Y 3,7 130 Intel Xeon E5-2660 v2 10 2.2 25 1866 8.0 Y Y Y 4,8 95 Intel Xeon E5-2650 v2 8 2.6 20 1866 8.0 Y Y Y 4,8 95 Intel Xeon E5-2650 v2 8 2.6 20 1866 8.0 Y Y Y 4,8 95 Intel Xeon E5-2643 v2 6 3.5 25 1866 8.0 Y Y Y 1,3 130 Intel Xeon E5-2643 v2 6 3.5 25 1866 8.0 Y Y Y 1,3 130 Intel Xeon E5-2643 v2 6 3.5 25 1866 8.0 Y Y Y 1,3 130 Intel Xeon E5-2643 v2 6 3.5 25 1866 8.0 Y Y Y 1,3 130	E5-2690 v2	10	3.0	25	1866	8.0	Y	Υ	3, 6	130
E5-2680 v2 processor	processor									
Intel Xeon	Intel Xeon									
Intel Xeon E5-2670 v2 10 2.5 25 1866 8.0 Y Y Y 4,8 115	E5-2680 v2	10	2.8	25	1866	8.0	Υ	Υ	3, 8	115
E5-2670 v2	processor									115
Description	Intel Xeon									
Intel Xeon E5-2667 v2 8 3.3 25 1866 8.0 Y Y 3,7 130 Processor Intel Xeon E5-2660 v2 10 2.2 25 1866 8.0 Y Y Y 4,8 95 Processor Intel Xeon E5-2650 v2 8 2.6 20 1866 8.0 Y Y Y 4,8 95 Processor Intel Xeon E5-2643 v2 6 3.5 25 1866 8.0 Y Y Y 1,3 130 E5-2643 v2 6 3.5 25 1866 8.0 Y Y Y 1,3 130 E5-2643 v2 E5-2643 v2	E5-2670 v2	10	2.5	25	1866	8.0	Y	Υ	4, 8	115
E5-2667 v2	processor									
Description	Intel Xeon									
Description	E5-2667 v2	8	3.3	25	1866	8.0	Y	Υ	3, 7	130
E5-2660 v2	processor								·	
processor Intel Xeon V Y Y Y 4, 8 95 E5-2650 v2 processor 8 2.6 20 1866 8.0 Y Y Y 4, 8 95 Intel Xeon E5-2643 v2 6 3.5 25 1866 8.0 Y Y Y 1, 3 130	Intel Xeon									
Description	E5-2660 v2	10	2.2	25	1866	8.0	Υ	Υ	4, 8	95
E5-2650 v2 8 2.6 20 1866 8.0 Y Y 4, 8 95 processor Intel Xeon E5-2643 v2 6 3.5 25 1866 8.0 Y Y Y 1, 3 130	processor									
E5-2650 v2 8 2.6 20 1866 8.0 Y Y 4, 8 95 processor Intel Xeon E5-2643 v2 6 3.5 25 1866 8.0 Y Y Y 1, 3 130	Intel Xeon								ĺ	
processor Intel Xeon E5-2643 v2 6 3.5 25 1866 8.0 Y Y 1, 3 130		8	2.6	20	1866	8.0	Y	Υ	4,8	95
Intel Xeon E5-2643 v2 6 3.5 25 1866 8.0 Y Y 1, 3 130	processor								, -	
E5-2643 v2 6 3.5 25 1866 8.0 Y Y 1, 3 130	•	Ì							i	
		6	3.5	25	1866	8.0	Y	γ	1.3	130
	processor	-	""	=•			'	_	-, -	

Overview									
Intel Xeon E5-2640 v2 processor	8	2.0	20	1600	7.2	Y	Y	3, 5	95
Intel Xeon E5-2637 v2 processor	4	3.5	15	1866	8.0	Y	Y	1, 3	130
Intel Xeon E5-2630 v2 processor	6	2.6	15	1600	7.2	Y	Y	3, 5	80
Intel Xeon E5-2620 v2 processor	6	2.1	15	1600	7.2	Y	Y	3, 5	80
Intel Xeon E5-2609 v2 processor	4	2.5	10	1333	6.4	N	Y	N/A	80
Intel Xeon E5-2603 v2 processor	4	1.8	10	1333	6.4	N	Y	N/A	80
Intel® Xeon® E5-1660 processor	6	3.3	15	1600	-	Y	Y	3, 6	130
Intel Xeon E5-1650 processor	6	3.2	12	1600	-	Y	Y	3, 6	130
Intel Xeon E5-1620 processor	4	3.6	10	1600	-	Y	Y	2, 3	130
Intel Xeon E5-1607 processor	4	3.0	10	1066	-	N	Y	N/A	130
Intel Xeon E5-1603 processor	4	2.8	10	1066	-	N	Y	N/A	130
Intel Xeon E5-1680 v2 processor	8	3.0	25	1866	-	Y	Y	4, 9	130
Intel Xeon E5-1660 v2 processor	6	3.7	15	1866	-	Y	Y	2, 3	130
Intel Xeon E5-1650 v2 processor	6	3.5	12	1866	-	Y	Y	1, 4	130
Intel Xeon E5-1620 v2 processor	4	3.7	10	1866	-	Y	Y	0, 2	130
Intel Xeon E5-1607 v2 processor	4	3.0	10	1600	-	N	Y	N/A	130



Overview	
	¹ The specifications shown in this column represent the following: (all core maximum turbo steps, one core maximum turbo steps). Turbo boost stepping occurs in 100MHz increments. Processors that do not have turbo functionality are denoted as N/A.
	NOTE: Z620 systems configured with E5-1600 series processors may not add a 2nd processor. To support two processors, E5-2600 series processor must be chosen.
Available Processor Disclaimers	When ordering two processors, the second processor must be the same as the first. Intel processor numbers are not a measurement of higher performance. Processor numbers differentiate features within each processor family, not across different processor families. See: http://www.intel.com/products/processor_number/ for details
	Multi-Core technologies are designed to improve performance of multithreaded software products and hardware-aware multitasking operating systems and may require appropriate operating system software for full benefits; check with software provider to determine suitability; Not all customers or software applications will necessarily benefit from use of these technologies.
	64-bit computing on Intel® 64 architecture requires a computer system with a processor, chipset, BIOS, operating system, device drivers, and applications enabled for Intel® 64 architecture. Processor will not operate (including 32-bit operation) without an Intel® 64 architecture-enabled BIOS. Performance will vary depending on your hardware and software configurations. See: http://www.intel.com/info/em64t for more information.
Additional Details	 Intel® Sandy Bridge Architecture Intel® C602 Chipset Intel® Xeon® processor E5-2600 product family Intel® Xeon® processor E5-2600 v2 product family Intel® Xeon® processor E5-1600 product family Intel® Xeon® processor E5-1600 v2 product family Intel® Xeon® processor E5-1600 v2 product family (Sandy Bridge, Socket R) Up to 8.0GT/s QPI support with two QPI links between processors 4-channel per processor 1066/1333/1600/1866 MHz DDR3 memory* subsystem Up to 192 GB Memory capacity with 12 DIMM slots and 16 GB DIMMs (with two processors installed) PCI Express I/O and dual PCIe x16 Gen3 graphics support Dual Integrated Intel Gigabit LAN on Motherboard (LOM) 2 channels of Serial ATA (SATA) 6.0 Gb/s and 8 channels of SATA 3.0 Gb/s natively supported internally SATA RAID 0, 1, 5, and 10 support standard on motherboard SAS RAID 0, 1, and 10 supported using the LSI 9212-4i 6Gb/s controller SATA optical drives High Definition integrated audio with internal speaker 800W 90% efficient power supply ENERGY STAR® qualification and energy-saving features available on selected configurations (Not supported by Linux) Protected by HP Services, including a 3 years parts, 3 years labor, and 3 years onsite service (3/3/3) standard warranty. Terms and conditions vary by country. Certain restrictions and exclusions apply. *Each processor supports up to 4 channels of DDR3 memory. To realize full performance at least 1 DIMM must be inserted into each channel. To get full 8 channel support, 2 processors MUST be installed.
Form Factor	4U Rackable Minitower
Color	Brushed aluminum & black
I/O Expansion Slots	Slot 1 (top): PCI Express Gen2 x4(1)* Full-height, Half-length



Overview								
	(not available when 2nd C	PU/Memory Module is installed)						
	Slot 2: PCI Express Gen3 x16 Full-height, Full-length (with							
		Slot 3: PCI Express Gen2 x8(4)* with open-ended connector** Full-height, Full-length (with extender)						
		Slot 4: PCI Express Gen3 x8 with open-ended connector** Full-height, Full-length (with extender)						
	Slot 5: PCI Express Gen3 x16 Full-height, Full-length (wit							
	Slot 6: PCI 32bit/33MHz Full-height, Full-length (with extender)							
	(number) = number of land x(#)electrical.	lanes or size of the physical/mechanical connector. es supported electrically. Typically communicated as x# mechanical, allow a greater bandwidth (e.g. x16) card to be installed physically into a						
	lower bandwidth connecto							
Mass Storage Bays (see	Total bays = 5							
Storage section for more details)								
Internal Bays	3 internal 3.5" bays (with a	acoustic dampening rail assemblies pre-installed)						
External Bays	2 external 5.25" bays							
	(4th HDD occupies one ex	rternal bay)						
Front I/O	2 USB 3.0, 1 USB 2.0, 1 H	Headphone, 1 Microphone, 1 IEEE 1394a						
Rear I/O	1 Microphone	RJ-45 integrated Gigabit LAN, 2 PS/2, 1 Audio Line-In, 1 Audio Line-Out, onal connector on PCI bracket cabled to system board connector						
Internal USB	6 USB 2.0 ports available	by three separate 2x5 headers. Each 2x5 header supports either one EM165AA) or one 22-in-1 Media Card Reader.						
Chassis Dimensions (H	44.45 x 17.15 x 46.48 cm	(17.5 x 6.75 x 18.3 in)						
x W x D)	Rack utilization: 4U							
System Weight	Actual weight depends upon Minimum config: 15.5 kg (Typical config: 17.9 kg (39) Maximum config: 22.6 kg	34.2 lb) 9.4 lb)						
Temperature	Operating: Non-operating	5° to 35° C (40° to 95° F) -40° to 60° C (-40° to 140° F)						
Humidity	Operating:	8% to 85% relative humidity, non-condensing 8% to 90% relative humidity, non-condensing						
Maximum Altitude (non-		3,048m (10,000ft)						
pressurized)	 i	9,144m (30,000ft)						
Power Supply	Tool-free 800W 90% Effici	ent wide-ranging, active Power Factor Correction ncy Report for this product may be found at this link: TBD						



	10-channel SATA Interface (2 @ 6.0 Gb/s and 8 @ 3.0 Gb/s). 6 channels are eSATA configurable (2 @ 6 Gb/s, 4 @ 3 Gb/s) for use with eSATA CTO/AMO Kit. No hot plug / hot swap supported.
Hard Drive Controllers Supported	SATA and SAS controllers
	For a complete listing of compatible DAT tape drives, LTO tape drives and RDX Removable Disk Backup System offerings, please visit http://www.hp.com/go/connect
	See the latest list of certifications at http://www.hp.com/united-states/campaigns/workstations/partnerships.html



Supported Components

Processors		Factory Configured	Option Kit	Option Kit Part Number	Support Notes
	Intel Xeon E5-2600 Series - CTO	_			
	Intel® Xeon® Processor E5-2620 6C 2.00GHz	Υ	N		
	Intel® Xeon® Processor E5-2643 4C 3.30GHz	Υ	N		
	Intel Xeon E5-1600 Series				
	Intel® Xeon® Processor E5-1620 4C 3.60GHz	Υ	N		
	Intel® Xeon® Processor E5-1603 4C 2.80GHz	Υ	N		
	Intel Xeon E5-2600 Series - Z620 AMO				
	Z620 Xeon E5-2620 6C 2.00 15MB 1333 CPU2	N	Υ	A6S74AA	
	Z620 Xeon E5-2643 4C 3.30 10MB 1600 CPU2	N	Υ	A6S77AA	
	Intel Xeon E5-2600 v2 Series - CTO				
	Intel® Xeon® Processor E5-2667 v2 8C 3.30GHz	Υ	N		
	Intel® Xeon® Processor E5-2650 v2 8C 2.60GHz	Υ	N		
	Intel® Xeon® Processor E5-2643 v2 6C 3.50GHz	Υ	N		
	Intel® Xeon® Processor E5-2695 v2 12C 2.40GHz	Υ	N		
	Intel® Xeon® Processor E5-2690 v2 10C 3.00GHz	Υ	N		
	Intel® Xeon® Processor E5-2637 v2 4C 3.50GHz	Υ	N		
	Intel® Xeon® Processor E5-2620 v2 6C 2.10GHz	Υ	N		
	Intel® Xeon® Processor E5-2603 v2 4C 1.80GHz	Υ	N		
	Intel® Xeon® Processor E5-2660 v2 10C 2.20GHz	Υ	N		
	Intel® Xeon® Processor E5-2630 v2 6C 2.60GHz	Υ	N		
	Intel® Xeon® Processor E5-2609 v2 4C 2.50GHz	Υ	N		
	Intel® Xeon® Processor E5-2640 v2 8C 2.00GHz	Υ	N		
	Intel® Xeon® Processor E5-2670 v2 10C 2.50GHz	Υ	N		
	Intel® Xeon® Processor E5-2697 v2 12C 2.70GHz	Υ	N		
	Intel® Xeon® Processor E5-2680 v2 10C 2.80GHz	Υ	N		
	Intel Xeon E5-1600 v2 Series				
	Intel® Xeon® Processor E5-1607 v2 4C 3.00GHz	Υ	N		
	Intel® Xeon® Processor E5-1620 v2 4C 3.70GHz	Υ	N		
	Intel® Xeon® Processor E5-1680 v2 8C 3.00GHz	Υ	N		
	Intel® Xeon® Processor E5-1660 v2 6C 3.70GHz	Υ	N		
	Intel® Xeon® Processor E5-1650 v2 6C 3.50GHz	Υ	N		
	Intel Xeon E5-2600 v2 Series - Z620 AMO				
	Z620 Xeon E5-2640 v2 8C 2.00 20MB 1600 CPU2	N	Υ	E3E09AA	
	Z620 Xeon E5-2667 v2 8C 3.30 25MB 1866 CPU2	N	Υ	E3E13AA	
	Z620 Xeon E5-2630 v2 6C 2.60 15MB 1600 CPU2	N	Υ	E3E07AA	
	Z620 Xeon E5-2650 v2 8C 2.60 20MB 1866 CPU2	N	Υ	E3E11AA	
	Z620 Xeon E5-2620 v2 6C 2.10 15MB 1600 CPU2	N	Υ	E3E06AA	
	Z620 Xeon E5-2603 v2 4C 1.80 10MB 1333 CPU2	N	Υ	E3E04AA	
	Z620 Xeon E5-2690 v2 10C 3.00 25MB 1866 CPU2	N	Υ	E3E16AA	
	Z620 Xeon E5-2637 v2 4C 3.50 15MB 1866 CPU2	N	Υ	E3E08AA	
	Z620 Xeon E5-2697 v2 12C 2.70 30MB 1866 CPU2	N	Υ	E3E18AA	



Supported Components

Z620	Xeon E5-2609 v2 4C 2.50 10MB 1333 CPU2	N	Υ	E3E05AA
Z620	Xeon E5-2670 v2 10C 2.50 25MB 1866 CPU2	N	Υ	E3E14AA
Z620	Xeon E5-2660 v2 10C 2.20 25MB 1866 CPU2	N	Υ	E3E12AA
Z620	Xeon E5-2695 v2 12C 2.40 30MB 1866 CPU2	N	Υ	E3E17AA
Z620	Xeon E5-2643 v2 6C 3.50 25MB 1866 CPU2	N	Υ	E3E10AA
Z620	Xeon E5-2680 v2 10C 2.80 25MB 1866 CPU2	N	Υ	E3E15AA

NOTE 1: When ordering two processors, the second processor must be the same as the first. Intel processor numbers are not a measurement of higher performance. Processor numbers differentiate features within each processor family, not across different processor families. See: http://www.intel.com/products/processor number/ for details.

Multi-Core technologies are designed to improve performance of multithreaded software products and hardware-aware multitasking operating systems and may require appropriate operating system software for full benefits; check with software provider to determine suitability; Not all customers or software applications will necessarily benefit from use of these technologies.

64-bit computing on Intel® 64 architecture requires a computer system with a processor, chipset, BIOS, operating system, device drivers, and applications enabled for Intel® 64 architecture. Processor will not operate (including 32-bit operation) without an Intel® 64 architecture-enabled BIOS. Performance will vary depending on your hardware and software configurations. See: http://www.intel.com/info/em64t for more information.

Intel's numbering is not a measurement of higher performance.

Z620 processor AMO kits include:

- 2nd CPU/Memory Module (riser)
- processor
- heat sink

SAS Hard Drives		Factory Configured	Option Kit	Option Kit Part Number	Support Notes
	HP SAS (Serial Attached SCSI) Hard Drives for HP We	orkstations			
	HP 300GB SAS 10K SFF HDD	Υ	Υ	A2Z20AA	
	HP 600GB SAS 10K SFF HDD	Υ	Υ	A2Z21AA	
	HP 900GB SAS 10K SFF HDD	Υ	Υ	E2P03AA	
	300GB SAS 15K rpm 6Gb/s 3.5" HDD	Υ	Υ	LU967AA	
	450GB SAS 15K rpm 6Gb/s 3.5" HDD	Υ	Υ	LU968AA	
	600GB SAS 15K rpm 6Gb/s 3.5" HDD	Υ	Υ	VM647AA	
	HP 900GB SAS 10K SFF HDD	Υ	Υ	E2P03AA	
	HP 1.2TB SAS 10K SFF HDD	Υ	Υ	E2P04AA	
	Sub-Section Description/Notes				
	NOTE: SAS Controller add-in card required				
SATA Hard Drives	SATA (Serial ATA) Hard Drives for HP Workstations				
	500GB SATA 7200 rpm 6Gb/s 3.5" HDD	Υ	Υ	LQ036AA	
	500GB SATA 7.2K SED SFF HDD	Υ	Υ	D8N29AA	
	1TB SATA 7200 rpm 6Gb/s 3.5" HDD	Υ	Υ	LQ037AA	
	2.0TB SATA 7200 rpm 6Gb/s 3.5" HDD	Υ	Υ	QB576AA	
	3.0TB SATA 7200 rpm 6Gb/s 3.5" HDD	Υ	Υ	QF298AA	
	250GB SATA 10K rpm SFF HDD	Υ	Y	B8X18AA	



Supported Com	ponents			
	500GB SATA 10K rpm SFF HDD	Υ	Υ	B8X19AA
	1TB SATA 10K rpm SFF HDD	Υ	Υ	B8X20AA
SATA Solid State	Drives HP Solid State Drives (SSDs) for Workstations			
	HP 128GB SATA 6Gb/s SSD	Υ	Υ	A3D25AA
	HP 256GB SATA 6Gb/s SSD	Υ	Υ	A3D26AA
	HP 256GB SATA 6Gb/s SED SSD	Υ	Υ	D8N28AA
	HP 512GB SATA 6Gb/s SSD	Υ	N	D8F30AA
	Intel Pro 1500 180GB SATA SSD	Υ	Υ	F5Z70AA
	Samsung SM843T 240GB SATA SSD	Υ	Υ	F0W94AA
	Samsung SM843T 480GB SATA SSD	Υ	Υ	F0W95AA
PCIe SSDs	PCIe SSDs for HP Workstations			
	Fusion ioFX 410GB PCIe Accelerator	Υ	Υ	E4W49AA

For hard drives, 1 GB = 1 billion bytes; TB = 1 trillion bytes. Actual formatted capacity is less. Up to 12 GB of hard drive (or system disk) is reserved for the system recovery software (XP and XP Pro). Up to 3 GB of system disk is reserved for system recovery software (Vista).

Up to 4 drives are allowed. The 4th drive will occupy one of the external 5.25" bays.

Hard Drive Controllers		Factory Configured	Option Kit	Option Kit Part Support Number Notes
	Integrated SATA 6.0 Gb/s Controller			
	Integrated SATA 6.0 Gb/s Controller	Υ	Ν	Two ports
	Integrated SATA 3.0 Gb/s Controller			
	Integrated SATA 3.0 Gb/s Controller	Υ	N	Eight ports
	Factory integrated RAID on motherboard for SATA dr	rives		
	RAID 0 Configuration - Striped Array	Υ	N	See note 1
	RAID 1 Configuration - Mirrored Array	Υ	N	See note 1
	RAID 10 Configuration - Striped/Mirrored Array	Υ	N	See note 1
	RAID 0 Data Configuration Boot/OS Drive + 2 Drive Striped Array	Υ	N	See note 1
	LSI 9217-4i4e 8-port SAS 6Gb/s RAID Card			
	LSI 9217-4i4e 8-port SAS 6Gb/s RAID Card	Υ	Υ	E0X20AA
	LSI 9270-8i SAS 6Gb/s ROC RAID Card	Υ	Υ	
	LSI 9270-8i SAS 6Gb/s ROC RAID Card	Υ	Υ	E0X21AA

RAID arrays greater than 2 TB are fully supported.

NOTE 1: Requires 2 identical hard drives (speeds, capacity, interface). RAID 1 does not support a 3rd HDD.

NOTE: Specific user-configured hardware SAS RAID configurations are supported on this system with Linux. For details, please visit: http://www.hp.com/support/linux hardware matrix

SATA hardware RAID is supported on Linux systems that have support for the Intel RSTe technology. The Linux kernel, with built-in software RAID, provides excellent functionality and performance. It is a good alternative to hardware-based RAID. Please visit

http://www.hp.com/support/linux_hardware_matrix for RAID capabilities with Linux.



Supported Components

NOTE: Specific user-configured hardware SAS RAID configurations are supported on this Linux system.

IS: Striping of 2 or more HDDs into a single logical volume

IM: Mirroring of 2 HDDs into a single logical volume

IME: Mirroring of 3 or more HDDs into a single logical volume

For details, please visit: http://www.hp.com/support/linux_hardware_matrix

Graphics

	Factory	Factory Option			Supported		
	Configured	Kit	Kit Part Number	Support Notes	# of cards	Mixed?	
Professional 2D							
NVIDIA NVS 310 512MB Graphics	Υ	Υ	A7U59AA		4	Yes	
NVIDIA NVS 315 1GB Graphics	Υ	Υ	E1U66AA		4	No	
NVIDIA NVS 510 2GB Graphics	Υ	Υ	C2J98AA	Note 1	2	Yes	

Graphics Cable Adapters

	Factory	Option	Option Kit Part	Sup	ported
	Configured	Kit		Support Notes # of card	s Mixed?
HP DisplayPort To DVI-D Adapter (4-Pack)	Υ	N		1	
HP DisplayPort To VGA Adapter 2nd	Υ	N		1	
HP DisplayPort To DVI-D Adapter (6-Pack)	Υ	N		1	
HP DisplayPort To DVI-D Adapter (2-Pack)	Υ	N		1	
HP DisplayPort to Dual Link DVI Adapter	Υ	Υ	NR078AA	1	
HP DisplayPort To VGA Adapter	Υ	Υ	AS615AA	1	
HP DisplayPort To DVI-D Adapter	Y	Υ	FH973AA	1	
Entry 3D					
NVIDIA Quadro 410 512MB Graphics	Υ	Υ	A7U60AA	2	No
NVIDIA Quadro K600 1GB Graphics	Υ	Υ	C2J92AA	2	No
AMD FirePro V3900 1GB Graphics	Υ	Υ	A6R69AA	2	No
Mid-range 3D					
NVIDIA Quadro K2000 2GB Graphics	Υ	Υ	C2J93AA	2	No
High End 3D					
NVIDIA Quadro K4000 3GB Graphics	Υ	Υ	C2J94AA	2	No
NVIDIA Quadro K5000 4GB Graphics	Υ	Υ	C2J95AA	2	No
AMD FirePro W7000 4GB Graphics	Υ	Υ	C2K00AA	2	No
NVIDIA Quadro K6000 12GB Graphics	Υ	Υ	C2J96AA	1	No
NOTE 1: If 1st card is NVS 510, 2nd card must be	ne NVS 510 or	NVS 310)		

NOTE 1: If 1st card is NVS 510, 2nd card must be NVS 510 or NVS 310.

Option

QuickSpecs

Supported Components

High	Performance
GPU	Computing

Option **Kit Part** Factory Support Configured Kit Number **Notes** Υ Υ C2J97AA NVIDIA Tesla K20c Compute Processor See note2 NVIDIA Tesla K40 Compute Processor Υ Υ F4A88AA See note 1

NOTE 1: Tesla K40 is supported with QK5000, QK600 or QK2000.

Not supported with 2 graphics cards.

Not supported with OS WIN32.

Not supported with OS WIN8.0.

NOTE 2: Tesla K20 is supported in combination with NVIDIA Quadro K600/K2000/K4000 1st graphics. Not supported with Win7 32-bit OS.

Memory CTO Option Kit Part Support Notes
Number

DDR3-1866 ECC Unbuffered DIMMs - CTO

2GB DDR3-1866 ECC Unbuffered RAM

4GB DDR3-1866 ECC Unbuffered RAM

8GB DDR3-1866 ECC Unbuffered RAM

DDR3-1866 ECC Registered DIMMs - CTO

4GB DDR3-1866 ECC Registered RAM

8GB DDR3-1866 ECC Registered RAM

16GB DDR3-1866 ECC Registered RAM

Sub-Section Description/Notes

The Z620 has a four-channel memory architecture. Four channels are associated with each processor. For optimal performance, populate a DIMM in each channel.

With single-processor configurations, 8 DIMM slots are available. Four additional DIMM slots are available with the 2nd CPU & Memory Module.

AMO

DDR3-1600 ECC Registered DIMMs - AMO

4GB DDR3-1600 ECC Registered RAM	A2Z49AA
8GB DDR3-1600 ECC Registered RAM	A2Z51AA
16GB DDR3-1600 ECC Registered RAM	A2Z52AA

DDR3-1600 ECC Unbuffered DIMMs - AMO

HP 2GB (1x2GB) DDR3-1600 ECC RAM	A2Z47AA
HP 4GB (1x4GB) DDR3-1600 ECC RAM	A2Z48AA

DDR3-1866 ECC Unbuffered DIMMs - AMO

HP 2GB (1x2GB)	DDR3-1866 ECC RAM	E2Q90AA
HP 4GB (1x4GB)	DDR3-1866 ECC RAM	E2Q91AA

DDR3-1866 ECC Registered DIMMs - AMO

HP 4GB (1x4GB) DDR3-1866 ECC Reg RAM	E2Q92AA
HP 8GB (1x8GB) DDR3-1866 ECC Reg RAM	E2Q94AA
HP 16GB (1x16GB) DDR3-1866 ECC Reg RAM	E2Q95AA

NOTE: Although all of these memory selections incorporate 1600MHz memory modules, the speed at which they operate is dependent upon the processor.

Supported Components

Multimedia and Audio				Option	
Devices		Factory Configured	Option Kit	Kit Part Number	Support Notes
	Creative Recon3D PCIe Audio Card	Υ	Υ	B0U68AA	
	Integrated Intel/Realtek HD ALC262 Audio	Υ	N		
	HP Thin USB Powered Speakers	Υ	Υ	KK912AA	

Optical and Removable Storage		Factory Configured	Option Kit	Option Kit Part Number Support Notes
	HP 16X DVD-ROM SATA Drive (non-Lightscribe version)	Y	Y	AR629AA See note 1
	HP 16X DVD+/-RW SuperMulti SATA Drive (non- Lightscribe)	Υ	Υ	QS208AA
	HP Blu-ray Writer	Υ	Υ	AR482AA See note 2
	HP DX115 Removable Drive Enclosure			
	HP DX115 Carrier with 160GB SATA HDD	N	Υ	FZ577AA
	HP DX115 Removable HDD Frame/Carrier	N	Υ	FZ576AA
	HP DX115 Removable HDD Carrier	N	Υ	NB792AA

Actual speeds may vary. Does not permit copying of commercially available DVD movies or other copyright protected materials. Intended for creation and storage of your original material and other lawful uses. Double Layer discs can store more data than single layer discs. However, double-layer discs burned with this drive may not be compatible with many existing single-layer DVD drives and players.

As Blu-ray is a new format containing new technologies, certain disc, digital connection, compatibility and/or performance issues may arise, and do not constitute defects in the product. Flawless playback on all systems is not guaranteed. In order for some Blu-ray titles to play, they may require a DVI or HDMI digital connection and your display may require HDCP support. HD-DVD movies cannot be played on this workstation.

NOTE 1: Not supported as a 2nd Optical Drive.

NOTE 2: Cannot be ordered in combination with another Blu-ray Writer.

Controller Cards		•	•	Option Kit Part Number	
	HP IEEE 1394b FireWire PCle Card	Υ	Υ	NK653AA	
	HP Thunderbolt-2 PCIe 1-port I/O Card	Υ	Υ	F3F43AA	



Supported Components

Networking and Communications		Factory Configured	Option Kit	Option Kit Part Number	Support Notes
	Integrated Intel 82579LM PCIe GbE Controller	Y	Ν		See note 2
	Broadcom NetXtreme Gigabit Ethernet Plus NIC (PCIe)	Υ	Υ	FS215AA	See notes 1 and 2
	Intel Gigabit CT Desktop NIC	N	Υ	FH969AA	See note 2
	HP X520 10GbE Dual Port Adapter	Υ	Υ	C3N52AA	See note 2
	HP 10GbE SFP+ SR Transceiver	Υ	Υ	C3N53AA	See note 2
	HP 361T PCIe Dual Port Gigabit NIC	N	Υ	C3N37AA	See note 2
	Intel Ethernet I210-T1 PCIe NIC	Υ	Υ	E0X95AA	See note 2

NOTE 1: This is a PCI Express card based on the Broadcom 5761 chip. This card does not support DASH 1.1 manageability on this platform.

NOTE 2: "Gigabit" Ethernet indicates compliance with IEEE standard 802.3ab for Gigabit Ethernet, and does not connote actual operating speed of 1 Gb/sec. For high speed transmission, connection to a Gigabit Ethernet server and network infrastructure is required.

Racking and Physical Security		Factory Configured	Option Kit	Option Kit Part Su Number N	pport otes
	Security Cable with Kensington Lock	N	Υ	PC766A	
	HP (CMT) Solenoid Lock	N	Υ	DE618A	
	HP Solenoid Hood Lock & Hood Sensor	Υ	N		
	HP Z6/8 Adjustable Rail Rack Kit, Flush Mount	N	Υ	B8S55AA	

Input Devices		Factory Configured	Option Kit	Option Kit Part Number Support Notes
	HP PS/2 Keyboard	Υ	Υ	QY774AA
	HP PS/2 Mouse	Υ	Υ	QY775AA
	HP USB Keyboard	Υ	Υ	QY776AA
	HP USB Optical Mouse	Υ	Υ	QY777AA
	HP USB 1000dpi Laser Mouse	Υ	Υ	QY778AA
	HP Wireless Keyboard and Mouse	N	Υ	QY449AA
	HP USB Smart Card Keyboard	N	Υ	E6D77AA
	HP USB Optical 3-Button 2.9M OEM Mouse	N	Υ	ET424AA
	HP SpaceMouse Pro USB 3D Input Device	N	Υ	B4A20AA
	HP SpacePilot Pro 3D USB Intelligent Controller	N	Υ	WH343AA
	Product numbers QY774AA-QY778AA represent the	e new 2012 pro	ducts with	the updated product

design. The previous models will be phased out over time.

Supported Components

Other Hardware		Factory Configured	Option Kit	Option Kit Part Number	Support Notes
	HP Workstation Mouse Pad	Υ	N		Japan only.
	HP Power Cord Kit	N	Υ	DM293A	
	HP eSATA PCI Cable Kit	N	Y	GM110AA	No hot plug / hot swap supported.
	HP Serial Port Adapter	N	Υ	PA716A	
	HP Internal USB Port Kit	N	Υ	EM165AA	Note 1
	HP Optical Bay HDD Mounting Bracket	Υ	Υ	NQ099AA	For 3.5" HDDs
	HP Energy Star Enabled Configuration	Υ	N		
	Note 1: The HP Internal USB Port kit has a single	e USB 2.0 type A	connector	r.	

Software		Factory Configured	Option Kit	Option Kit Part Number	Support Notes
	HP Performance Advisor	Υ	Υ		See note 1
	HP Remote Graphics Software (RGS) 6.0	Υ	N		See note 2
	HP ProtectTools Security	Υ	N		See note 3
	HP Power Assistant	Υ	N		Win7 only
	PDF Complete - Trial Edition	Υ	N		
	Cyberlink Media Suite & PowerDVD	Υ	N		Media playback and authoring software
	MS Office Home & Business 2013	Υ	N		See note 3

NOTE 1: Available as a free download here: www.hp.com/go/performanceadvisor

NOTE 2: Supports both 32 and 64 bit versions of Windows 7 Professional and Enterprise,

Windows XP Professional and Enterprise, and RHEL V6

NOTE 3: Must select as a Configure to Order option. Delivered as a "Drop in the Box" CD. Not Supported with Windows 7 Ultimate. Not Supported with Linux.



Supported Components

Operating Systems Support Notes

Genuine Windows® 7 Ultimate

64-bit

Genuine Windows® 7 See note 1

Professional 64-bit

Genuine Windows® 7 See note 1

Professional 32-bit HP Linux Installer Kit

Red Hat Enterprise Linux (RHEL) See note 2

Workstation - Paper License (1yr)

Windows 8.1 Pro 64-bit

Windows 8.1 Simplified Chinese

Edition 64-bit

Windows 8.1 Pro Downgrade to

Windows 7 Professional 64-bit

Windows 8.1 Pro Downgrade to

Windows 7 Professional 64-bit

(National Academic)

Windows 8.1 Pro Downgrade to

Windows 7 Professional 32-bit

Windows 8.1 Pro Downgrade to

Windows 7 Professional 32-bit

(National Academic)

NOTE 1: See http://www.microsoft.com/windows/windows-7/ for support details.

See note 1

NOTE 2: This second OS must be ordered with the HP Linux Intaller Kit as the first OS.



System Board				
System Board Form Factor	Main System Board: 24 x 31 cm 9.6 x 12.2 inches 2nd CPU/Memory Board (optional): 14.9 x 29.2 cm 5.85 x 11.50 inches			
Processor Socket	LGA2011 1st CPU on system board 2nd CPU on optional 2nd CPU/Memory Module			
CPU Bus Speed	QPI: Up to 8.0GT/second, depending on processor			
Chipset	Intel C602 Chipset			
Super I/O Controller	Nuvoton NPCD379H (SIO-12)			
Memory Expansion Slots	8 on system board(CPU0) + 4 on optional 2nd CPU/Memory Module (CPU1)			
Memory Type Supported	DDR3, UDIMM (Unbuffered), ECC: 2GB and 4GB DDR3, RDIMM (Registered), ECC: 4GB, 8GB, and 16GB			
Memory Modes	NUMA (Non-Uniform Memory Architecture), Memory Node Interleave			
Memory Speed Supported	1066, 1333, & 1600MHz			



¤	¤				Single·P	rocesso	r¤		
¤	¤		CPU0↔ Front·Slots¤					U0⊷ ·Slots¤	
Capacity⊷ (GB)¤	Type [□]	DIMM·	DIMM· 2 ^{II}	3¤	DIMM·	DIMM· 5¤	6α DIWW∙	DIMM∙ 7 [□]	8¤ DIWW∙
4¤	UDIMM¤	4GB¤	°¤	°¤	ο¤	°¤	°¤	°¤	°¤
8¤	UDIMM¤	4GB¤	°¤	°¤	°¤	°¤	°¤	°¤	4GB¤
12¤	UDIMM¤	4GB¤	°¤	4GB¤	°¤	°¤	°¤	°¤	4GB¤
16¤	UDIMM¤	4GB¤	°¤	4GB¤	°¤	°¤	4GB¤	°¤	4GB¤
24¤	UDIMM¤	4GB¤	4GB¤	4GB¤	°¤	٥¤	4GB¤	4GB¤	4GB¤
32¤	UDIMM¤	4GB¤	4GB¤	4GB¤	4GB¤	4GB¤	4GB¤	4GB¤	4GB¤
32¤	UDIMM¤	8GB¤	°¤	8GB¤	°¤	°¤	8GB¤	°¤	8GB¤
32¤	RDIMM¤	8GB¤	°¤	8GB¤	°¤	°¤	8GB¤	°¤	8GB¤
48¤	UDIMM¤	8GB¤	4GB¤	8GB¤	4GB¤	4GB¤	8GB¤	4GB¤	8GB¤
64¤	UDIMM¤	8GB¤	8GB¤	8GB¤	8GB¤	8GB¤	8GB¤	8GB¤	8GB¤
64¤	RDIMM¤	8GB¤	8GB¤	8GB¤	8GB¤	8GB¤	8GB¤	8GB¤	8GB¤
64¤	RDIMM¤	16GB¤	°¤	16GB¤	°¤	°¤	16GB¤	°¤	16GB¤
96¤	RDIMM¤	16GB¤	8GB¤	16GB¤	8GB¤	8GB¤	16GB¤	8GB¤	16GB¤
128¤	RDIMM¤	16GB¤	16GB¤	16GB¤	16GB¤	16GB¤	16GB¤	16GB¤	16GB¤
Slot-Load	·Order¤	η¤	5¤	3¤	7¤	8¤	4¤	6¤	2¤

n	п						Dual-P	rocessor	a				
¤	¤			U0⊷ •Slots¤		CPU0⊷ Rear∙Slots¤				CPU1↔ Front·Slots [□]		CPU1↔ Rear·Slots¤	
Capacity↔ (GB) [©]	Type [□]	DIWM∙ 1¤	DIMM- 2 ^{II}	3¤ DIWW∙	DIMM- 4 ^{II}	DIMM- 5 ^{II}	DIWW∙	DIMM· 7º	DIWW∙	DIMM-	DIMM- 2 ^{II}	3¤	DIMM-
8¤	UDIMM¤	4GB¤	٥¤	ο¤	٥¤	°¤	°p	٥p	ομ	4GB¤	ο¤	ο¤	οĦ
16¤	UDIMM¤	4GB¤	°¤	°¤	°¤	°¤	°¤	°¤	4GB¤	4GB¤	°¤	°¤	4GB¤
24¤	UDIMM¤	4GB¤	°¤	4GB¤	ο¤	°E	°¤	op	4GB¤	4GB¤	4GB¤	°E	4GB¤
32¤	UDIMM¤	4GB¤	°¤	4GB¤	٥¤	°¤	4GB¤	°¤	4GB¤	4GB¤	4GB¤	4GB¤	4GB¤
40¤	UDIMM¤	4GB¤	4GB¤	4GB¤	°¤	°¤	4GB¤	4GB¤	4GB¤	4GB¤	4GB¤	4GB¤	4GB¤
48≅	UDIMM¤	4GB¤	4GB¤	4GB¤	4GB¤	4GB¤	4GB¤	4GB¤	4GB¤	4GB¤	4GB¤	4GB¤	4GB¤
64¤	UDIMM¤	8GB¤	°¤	8GB¤	°¤	°¤	8GB¤	°E	8GB¤	8GB¤	8GB¤	8GB¤	8GB¤
64¤	RDIMM¤	8GB¤	°72	8GB¤	°72	°¤	8GB¤	op	8GB¤	8GB¤	8GB¤	8GB¤	8GB¤
96¤	UDIMM¤	8GB¤	8GB¤	8GB¤	8GB¤	8GB¤	8GB¤	8GB¤	8GB¤	8GB¤	8GB¤	8GB¤	8GB¤
96¤	RDIMM¤	16GB¤	°¤	8GB¤	°PI	°¤	8GB¤	°p	16GB¤	16GB¤	8GB¤	8GB¤	16GB¤
128¤	RDIMM≅	16GB¤	٥¤	16GB¤	٥¤	٥¤	16GB¤	°¤	16GB¤	16GB¤	16GB¤	16GB¤	16GB
160¤	RDIMM¤	16GB¤	8GB¤	16GB¤	8GB¤	8GB¤	16GB¤	8GB¤	16GB¤	16GB¤	16GB¤	16GB¤	16GB ^E
192¤	RDIMM¤	16GB¤	16GB¤	16GB¤	16GB¤	16GB¤	16GB¤	16GB¤	16GB¤	16GB¤	16GB¤	16GB¤	16GB¤
Slot-Load	·Order¤	Į¤	9¤	5¤	11¤	12¤	7¤	10¤	3¤	2¤	6¤	8¤	4¤

Maximum Memory	Supports up to 192GB with two pro-	cessors and (12) 16 GB DIMMs		
Memory Configuration (Supported)	 Not all memory configurations possible are represented above. Only ECC DIMMs are supported. Do not install memory modules into memory slots if corresponding processor is not installed. Dual processor configurations with memory modules installed for only one processor is not supported. UDIMM (Unbuffered) and RDIMM (Registered) memory cannot be mixed. All memory installed in the system must be either UDIMM or RDIMM. 			
PCI Express Connectors	Slot 1 (top): PCI Express Gen2 x4(1)* Full-height, Half-length (not available when 2nd CPU/Memo	ory Module is installed)		
	Full-height, Full-length (with extender) Slot 3: PCI Express Gen2 x8(4)* with open-ended connector** Full-height, Full-length (with extender)			
	Slot 4: PCI Express Gen3 x8 with open-ended connector** Full-height, Full-length (with extender)			
	Slot 5: PCI Express Gen3 x16 Full-height, Full-length (with extender)			
	(number) = number of lanes support x(#)electrical.	size of the physical/mechanical connector. ted electrically. Typically communicated as x# mechanical eater bandwidth (e.g. x16) card to be installed physically ot.		
PCI Connectors (5.0V)	Slot 6: PCI 32bit/33MHz Full-height, Full-length (with extended)			
Supported Drive Interfaces	SATA	Integrated 10-channel SATA interface (2@6Gb/s, 8@3Gb/s). Supports RAID 0, 1, 5, 10 and NCQ. Factor integrated RAID is Microsoft Windows only.		
	Serial Attached SCSI	Requires Optional PCIe card		
Integrated RAID	 RAID 1 configuration - mirrore RAID 5 parity striping (suppor RAID 10 striped and mirrored 	2-4 drives array (supported and configure to order) d array (supported and configure to order) ted but not configure to order)		



Integrated Graphics	No		
Network Controller	 Integrated Intel 82579 and 82574 Controllers. Memory Integrated 48KB receive buffer and 8KB transmit buffer Data rates supported 10/100/1000 Mb/s Compliance IEEE 802.3, 802.3AB and 802.3u compliant, 802.3x flow control Bus architecture PCle 1.0a Data path width X1 Data path speed 2.5Gbit per sec per direction transfer rate Data transfer mode Bus-master DMA Power requirement 1.0 watts @ +3.3V AUX supply Boot ROM support Yes Network transfer rate 10BASE-T (half-duplex) 10 Mb/s 10BASE-T (full-duplex) 20 Mb/s 100BASE-TX (half-duplex) 100 Mb/s 100BASE-TX (full-duplex) 2000 Mb/s 1000BASE-T (full-duplex) 2000 Mb/s Microsoft Windows Vista Business 32 and 64, Microsoft Windows XP Professional 32 and 64 Management capabilities AMT/vPro Technology 		
SATA Connectors	10 ports/connectors (6 ports may be cabled to optional eSATA cable kits [2 ports per cable kit] No hot plug / hot swap supported.		
IEEE 1394a or 1394b	1394a is integrated 1394b is optional with PCIe card Cable from Front IO can be plugged into PCIe Card. Not supported in Linux		
IEEE 1394 Connector(s)	Front	1 - 1394a	
. ,	Rear	1 - 1394a	
	Internal	No	
USB Connector(s)	Front	1 - USB 2.0 2 - USB 3.0	
	Rear	4 - USB 2.0 2 - USB 3.0	
	Internal	6 USB 2.0 ports available with three separate 2x5 headers. Each header supports either a HP Internal USB Port Kit (EM165AA) or USB Media Card reader. Each Internal Port Kit has one (1) USB 2.0 connector. Third-Party adaptors are available to convert the 2x5 headers to two USB 2.0 connectors. For these solutions the adaptor should include a minimum of 8 inches of cable between the 2x5 female connector and the USB 2.0 connector to insure sufficient cable-routing length.	
HD Integrated Audio	Realtek ALC262		
Flash ROM	Yes		
CPU Fan Header	One for each CPU socket		
Chassis Fan Header	Rear System Chassis Fan Header Front System Chassis Fan Header		
CMOS Battery Holder – Lithium	Yes		
Integrated Trusted Platform Module	TPM 1.2, Infineon		
Power Supply Headers	Yes		
	-		



System Technical Specifications					
Power Switch, Power LED & Hard Drive LED Header	Yes (includes s	Yes (includes speaker and intrusion sensor signals)			
Clear Password Jumper	Yes	Yes			
Serial Port	Optional	Optional			
Parallel Port	No	No			
Keyboard/Mouse	PS/2				
Z620 Required Power Supply I	nfo				
Power Supply		800W 90% Efficient, Custom PSU (Wide Ranging, Active PFC)			
Operating Voltage Range		90–269 VAC			
Rated Voltage Range		100–240 V	118 V		
Rated Line Frequency		50–60 Hz	400 Hz		
Operating Line Frequency Rai	nge	47–66 Hz	393–407 Hz		
Rated Input Current		9.7 A @ 100-240 V	9.7 A @ 400 V		
Hard Blackweller		T 4070 b			

ratoa inpat Garront	0.7 7 (Wg 100 Z 10 V	0.7 7 (62		
Heat Dissipation	Typical = 1972 btu/hr (497 kcal/hr)			
(Configuration and software dependent)	Maximum = 3139	btu/hr (791 kcal/hr)		
Bower Supply Fon	02v25 mm v	ariable speed		

Power Supply Fan	92x25 mm variable speed
ENERGY STAP Qualified	Vac

ı	(Configuration dependent)	
ı	80 PLUS® Compliant	Yes, 90% Efficient

The Z620 800W power supply efficiency report can be found at this link:
040,000044

	S10-800P1A				
FEMP Standby Power Compliant @115V	Yes				
(<2W in S5 - Power Off)					

EuP Co	ompliant @ 230V	Yes
(<0.5 W	V in S5 - Power Off)	

CECP Compliant @ 220V	Yes; Configuration dependent
(<4W in S3 - Suspend to RAM)	

- 1	(TTT III GG GGGGGIG to TU III)	
	Power Consumption in sleep mode	<15W
	(as defined by ENERGY STAR) - Suspend to RAM	
	(S3) (Instantly Available PC)	

(c c) (c c c c c c c c c c c c c c c	l
Built-in Selft Test LED	Yes
Surge Tolerant Full Ranging Power Supply	Yes

(withstands power surges up to 2000V)	

Access Panel Solenoid Lock Header	Yes				
Access Panel Intrusion Sensor Header	Yes Integrated in Front User Interface (Power Switch, Power LED, HDD LED, Speaker) Cable				
Multibay Header	No				
Integrated Gigabit Ethernet	Integrated Intel 82579 and 82574 Controllers				
Wake on LAN	Yes				
ASF 1.0/2.0 (Alert Standard Format)	No				
ТРМ	Integrated TPM 1.2; Infineon				
Password Clear Header	Yes				



System Technical Specifications

AUX IN (audio)	No
Clear CMOS Button	Yes
Memory Fan Header	CPU0 Memory Fan Header; CPU1 Memory Fan Header

System Configuration

Example Configuration		1x Intel Xeon E5-2650 (Eight-Core)							
#1	Memory Info	4x 2GB DDF	4x 2GB DDR3 1600 (UDIMM)						
(ENERGY STAR	Graphics Info	1x NVIDIA C	Quadro 600						
QUALIFIED)	Disks/Optical/Floppy	1x 250GB S	ATA 7200/1	x 16X DVD-I	ROM SATA				
	Power Supply	800W 90%	Custom PSI	J					
	Other	1x NVIDIA T	esla C2075						
Energy Consumption		115	VAC	230	VAC	100	VAC		
		LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled		
	Windows Idle (S0)	111	l W	110) W	111	I W		
	Windows Busy Typ (S0)	287 W 276 W 286 W					6 W		
	Windows Busy Max (S0)	396	3 W	390 W		398 W			
	Sleep (S3)	4.25 W 4.10 W		4.43 W	4.31 W	4.25 W	4.11 W		
	Off (S5)	1.81 W	1.62 W	2.07 W	1.89 W	1.79 W	1.61 W		
	Zero Power Mode (ErP)	0.2	5 W	0.4	5 W	0.23	3 W		
Heat Dissipation**		115	VAC	230	VAC	100	VAC		
		LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled		
	Windows Idle (S0)	379 b	otu/hr	375 b	otu/hr	379 b	otu/hr		
	Windows Busy Typ (S0)	979 b	tu/hr	942 b	tu/hr	976 b	otu/hr		
	Windows Busy Max (S0)	1351	btu/hr	1331	btu/hr	1358 btu/hr			
	Sleep (S3)	14.5 btu/hr 14.0 btu/hr 15.1 btu/hr 14.7 btu/hr 14.5 btu/hr 14.0 btu/				14.0 btu/hr			
	Off (S5)	6.18 btu/hr	5.53 btu/hr	7.06 btu/hr	6.45 btu/hr	6.11 btu/hr	5.49 btu/hr		
	Zero Power Mode (ErP)	0.85 btu/hr 1.54 btu/hr 0.78 btu/hr							

	Zero Power Mode (ErP)	0.82	btu/hr	1.54	btu/hr	0.78	otu/hr
	Off (S5)	6.18 btu/hr	4.71 btu/hr	7.06 btu/hr	5.60 btu/hr	6.07 btu/hr	4.64 btu/hr
	Sleep (S3)	15.1 btu/hr 14.7 btu/hr		15.8 btu/hr	15.4 btu/hr	15.1 btu/hr	14.8 btu/hr
	Windows Busy Max (S0)	659 b	otu/hr	648 btu/hr		659 btu/hr	
	Windows Busy Typ (S0)	0) 580 btu/hr 577 btu/hr 583 btu/hr					otu/hr
	Windows Idle (S0)	228 b	otu/hr	226 b	tu/hr	228 b	tu/hr
						LAN Enabled	
Heat Dissipation**			VAC	230 VAC		100 VAC	
	Zero Power Mode (ErP)		4 W		5 W	0.23	
	Off (S5)			1.36 W			
	Sleep (S3)	4.43 W 4.31 W		4.62 W	4.51 W	4.43 W	4.33 W
	Windows Busy Max (S0)						
	Windows Busy Typ (S0)						
	Windows Idle (S0)		8 W		3 W	66.9	i
						LAN Enabled	
Energy Consumption	Other	115	VAC	230	VAC	100	VAC
	Other	000VV 90%	Custom PSt	J			
QUALIFIED)		2x 500GB S 800W 90%			ROM SATA		
(ENERGY STAR	Graphics Info	1x NVIDIA N		40) (D) (D			
#2	,	4x 4GB DDR3 1600 (UDIMM)					
Example Configuration	Processor Info	1x Intel Xeon E5-2643 (Four-Core)					



Example Configuration Processor Info 2x Intel Xeon E5-2690 (Eight-Core)									
#3			xx 8GB DDR3 1600 (RDIMM)						
(ENERGY STAR	Graphics Info	1x NVIDIA C	`	,					
QUALIFIED)	Disks/Optical/Floppy	2x 250GB S	ATA 7200/1	x 16X DVD+	RW Superl	Multi SATA			
		800W 90%			·				
	Other	-							
Energy Consumption		115	VAC	230	VAC	100	VAC		
		LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled		
	Windows Idle (S0)	121 W 120 W 122 W							
	Windows Busy Typ (S0)	506 W 494 W 518 W					3 W		
	Windows Busy Max (S0)	541 W 531 W 544 W			↓ W				
	Sleep (S3)	7.75 W 7.57 W		7.84 W	7.67 W	7.82 W	7.62 W		
	Off (S5)	1.97 W 1.57 W 2.18 W 1.82 W 1.96 W 1.5			1.55 W				
	Zero Power Mode (ErP)	0.24 W 0.44 W 0.23 W							
Heat Dissipation**		115	VAC	230	VAC	100 VAC			
		LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled		
	Windows Idle (S0)	413 b	tu/hr	409 b	otu/hr	416 b	otu/hr		
	Windows Busy Typ (S0)	1727	btu/hr	1686	btu/hr	1767	btu/hr		
	Windows Busy Max (S0)	1846	btu/hr	1812 btu/hr		1856 btu/hr			
	Sleep (S3)	26.4 btu/hr 25.8 btu/hr 26.8 btu/hr 26.2 btu/hr 26.7 btu/hr 26.0				26.0 btu/hr			
	Off (S5)	6.72 btu/hr	5.36 btu/hr	7.44 btu/hr	6.21 btu/hr	6.69 btu/hr	5.29 btu/hr		
	Zero Power Mode (ErP)	0.82	otu/hr	1.50	btu/hr	0.78	btu/hr		

	ì						1
Example Configuration	Processor Info	2x Intel Xeon E5-2620 (Six-Core)					
#4	Memory Info	12x 4GB DDR3 1600 (UDIMM)					
	Graphics Info	2x NVIDIA (Quadro 5000				
	Disks/Optical/Floppy	4x 600GB S	SAS 15K/1x	16X DVD+-F	RW SuperMu	ılti SATA	
	Power Supply	800W 90%	Custom PSI	J	-		
	Other	LSI 9212 SA	AS Card				
Energy Consumption		115	VAC	230	VAC	100	VAC
		LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled
	Windows Idle (S0)	216	6 W	213	3 W	217	7 W
	Windows Busy Typ (S0)	525 W 485 W 512 W					
	Windows Busy Max (S0)	644 W 631 W 647 W				7 W	
	Sleep (S3)	9.27 W 8.81 W		9.36 W	8.91 W	9.31 W	8.89 W
	Off (S5)	1.85 W 1.43 W 2.12 W 1.68 W 1.83 W 1.41				1.41 W	
	Zero Power Mode (ErP)	0.25 W 0.45 W 0.23 W					
Heat Dissipation**		115 VAC		230 VAC		100 VAC	
		LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled
	Windows Idle (S0)	737 b	otu/hr	727 k	otu/hr	740 b	otu/hr
	Windows Busy Typ (S0)	1791	btu/hr	1655	btu/hr	1747	btu/hr
	Windows Busy Max (S0)	2197 btu/hr 2153 btu/hr 2208 btu/hr				btu/hr	
	Sleep (S3)	31.6 btu/hr 30.1 btu/hr 31.9 btu/hr 30.4 btu/hr 31.8 btu/hr 30.3 btu				30.3 btu/hr	
	Off (S5)	6.31 btu/hr 4.88 btu/hr 7.23 btu/hr 5.73 btu/hr 6.24 btu/hr 4				4.81 btu/hr	
	Zero Power Mode (ErP)	0.85	btu/hr	1.54	btu/hr	0.78	btu/hr

Declared Noise Emissions (Entry-level and High-end configurations)		
System Configuration	Processor Info	Single Intel Xeon E5-2640 2.50 GHz
(Entry level)	Memory Info	4 - 2 GB DDR3 1333 MHz UDIMM
	Graphics Info	NVIDIA Q400
	Disks/Optical/Floppy	Single 1 TB 7200 RPM SATA DVD ROM

Declared Noise Emissions (in		Sound Power (LWAd, bels)	Deskside Sound Pressure (LpAm, decibels)
accordance with ISO	Idle	3.3	16
	Hard drive Operating (random reads)	3.9	22
	DVD-ROM Operating (sequential reads)	5.1	39

System Configuration	Processor Info	Dual Xeon E5-2690 2.90 GHz
(High-end)	Memory Info	12 - 4GB DDR3 1600 MHz UDIMM
	Graphics Info	NVIDIA Q4000
	Disks/Optical/Floppy	Dual 600 GB 15K RPM SAS 3.5"
		DVD ROM

Declared Noise Emissions (in		Sound Power (LWAd, bels)	Deskside Sound Pressure (LpAm, decibels)
accordance with ISO 7779 and ISO 9296)	Idle	4.4	29
	Hard drive Operating (random reads)	4.8	32
	DVD-ROM Operating (sequential reads)	5.1	36

Environmental Requirements	Temperature	Operating: 5°C to 35°C (40°F to 95°F) Non-operating: -40°C to 60°C (-40°F to 140°F)
	Humidity	Operating: 8% to 85% RH, non-condensing Non-operating: 8% to 90% RH, non-condensing
	Maximum Altitude	Operating: 3,048 m (10,000 ft) Non-operating: 9,144 m (30,000 ft)
	Dynamic (new)	Shock Operating: ½-sine: 40 g, 2-3ms (~62 cm/sec) Non-operating: ½-sine: 160 cm/s, 2-3ms (~105 g) square: 20 g, 422 cm/s NOTE: Values represent individual shock events and do not indicate repetitive shock events. Vibration Operating random: 0.5 g (rms), 5-300 Hz, up to 0.0025 g²/Hz Non-operating random: 2.0 g (rms), 5-500 Hz, up to 0.0150 g²/Hz NOTE: Values do not indicate continuous vibration.

Cooling	Above 1524m (5,000 ft) altitude, maximum operating temperature is de-
	rated by 1°C (1.8°F) per 305m (1,000 ft) elevation increase

Access Panel	Tool-less
Access i allei	Includes system board and memory information
Optical Drive	Tool-less, no carrier or rails required
Hard Drives	Tool-less
	Integrated blind-mate drive carriers
	Optional 5.25" external bay carriers
Expansion Cards	Tool-less
Processor Socket	1st socket on main system board. 2nd socket on optional 2nd CPU/Memory Module.
Green User Touch Points	Yes, on primary serviceable components
Color-coordinated Cables and Connectors	Yes
Memory	Tool-less
System Board	Tool-less 2nd CPU/Memory Module: Tool-less
Dual Color Power and HD LED on Front of Computer	Yes
Configuration Record SW	Yes
Over-Temp Warning on Screen	Yes, at POST screen on reboot.
Restore CD/DVD Set	Yes, restores the computer to its original factory shipping image - Can be obtained via HP Support.
Dual Function Front Power Switch	Yes, also acts as a reset switch when held for 4 seconds.
Padlock Support	No
Cable Lock Support	Yes, Kensington Cable Lock (optional): Prevents entire system theft only. 3mm x 7mm slot at rear of system
Universal Chassis Clamp Lock Support	No
Solenoid Lock and Hood Sensor	Access Panel Solenoid Lock: Yes (optional). Activated remotely to prevent system entry. Access Panel Intrusion Sensor: Yes (optional).
Rear Port Control Cover	No
Removable Media Write/Boot Control	Yes, user can prevent the workstation from writing to or booting from removable media.
Power-On Password	Yes, prevents an unauthorized person from booting up the computer.
Setup Password	Yes, prevents an unauthorized person from changing the system configuration.
3.3V Aux Power LED on System PCA	No
NIC LEDs (integrated) (Green & Amber)	Yes
CPUs and Heatsinks	CPU heatsink removal requires a T-15 Torx or flat blade screwdriver. CPU removal is tool-less.



System reclinical Spe	20110ation 10
Power Supply Diagnostic	Yes
Front Power Button	Yes
Rear Power Button	Yes
Front Power LED	Yes, blue (normal), red (fault)
Front Hard Drive Activity LED	
Front ODD Activity LED	Yes
Internal Speaker	Yes
System/Emergency ROM Flash Recovery	Recovers corrupted system BIOS
Cooling Solutions	Air cooled forced convection
Power Supply Fans	1 - 92mm
CPU Heatsink Fan	1st CPU: 1 - 92mm Optional 2nd CPU: 1 - 92mm
Memory Heatsink Fan	System Board Memory: rear bank: 1 - 60mm, front bank: 1 - 40mm Optional 2nd CPU/Memory Module: rear bank: 1 - 80mm.
HP Vision Diagnostics Offline Edition	HP Vision Diagnostics Offline Edition The diagnostics utility enables you to perform testing and to view critical computer hardware and software configuration information from various sources. This utility enables you to:
	 Run diagnostics View the hardware configuration of the system Key features and benefits HP Vision Diagnostics simplifies the process of effectively identifying, diagnosing, and isolating the hardware issues. In addition to robust management tools, service tools can be invaluable in quickly
	resolving system problems. To streamline the service process and resolve problems quickly, it is necessary to have the right information available at the time that a service call is placed. The primary information requirement, which is also the one that provides the greatest Vision into potential system issues, is the configuration of the system. Vision diagnostics helps provide higher system availability. Typical uses of the Vision Diagnostics are:
	 Testing and diagnosing apparent hardware failures Documenting system configurations for upgrade planning, standardization, inventory tracking, disaster recovery, and maintenance Sending configuration information to another location for more in-depth analysis
Access Panel Key Lock	Yes, prevents removal of the access panel and all internal components including devices installed in the external 5.25" bays.
ACPI-Ready Hardware	Advanced Configuration and Power Management Interface (ACPI).
	 Allows the system to wake from a low power mode Controls system power consumption, making it possible to place individual cards and peripherals in a low-power or powered-off state without affecting other elements of the system
Trusted Platform Module Chip with optional ProtectTools Software	Yes, Infineon SLB9635TT1.2
Integrated Chassis Handles	Yes
Power Supply	Tool-less. Includes integrated handle.



PCI Card Retention	Yes, tool-less Rear (all) Middle (full-height cards) Front (full-length cards with extender)
Flash ROM	SPI ROM
Diagnostic Power Switch LED on board	Yes
Clear Password Jumper	Yes
Clear CMOS Button	Yes
CMOS Battery Holder	Yes
DIMM Connectors	Yes
HP ProtectTools Security Manager	Yes - Not supported on Linux

BIOS	
BIOS 32-bit Services	Standard BIOS 32-Bit Service Directory Proposal v0.4
PCI 3.0 Support	Full BIOS support for PCI Express through industry standard interfaces
ATAPI	ATAPI Removable Media Device BIOS Specification Version 1.0
BBS	BIOS Boot Specification v1.01
WMI Support	WMI is Microsoft's implementation of Web-Based Enterprise Management (WBEM) for Windows. WMI is fully compliant with the Distributed Management Task Force (DMTF) Common Information Model (CIM) and WBEM specifications.
BIOS Boot Spec 1.01+	Provides more control over how and from what devices the workstation will boot
BIOS Power On	Users can define a specific date and time for the system to power on
ROM Based Computer Setup Utility (F10)	Review and customize system configuration settings controlled by the BIOS
System/Emergency ROM Flash Recovery with Video	Recovers system BIOS in corrupted Flash ROM
Replicated Setup	Saves BIOS settings to diskette or USB flash device in human readable file. Repset.exe utility can then replicate these settings on machines being deployed without entering Computer Configuration Utility (F10 Setup).
SMBIOS	System Management BIOS 2.7 for system management information
Boot Control	Disables the ability to boot from removable media on supported devices
Memory Change Alert	Alerts management console if memory is removed or changed
Thermal Alert	 Monitors the temperature state within the chassis. Three modes: NORMAL - normal temperature ranges. ALERTED - excessive temperatures are detected. Raises a flag so action can be taken to avoid shutdown or provide for a smoother system shutdown. SHUTDOWN - excessive temperatures are encountered. Automatically shuts down the computer without warning before hardware component damage occurs.
Remote ROM Flash	Provides secure, fail-safe ROM image management from a central network console
ACPI (Advanced Configuration and Powe Management Interface)	Allows the system to enter and resume from low power modes (sleep states). Enables an operating system to control system power consumption based on the dynamic workload. Makes it possible to place individual cards and peripherals in a low-power or powered-off state without affecting other elements of the system. Supports ACPI 2.0 for full compatibility with 64-bit operating systems.



Ownership Tag	A user-defined string stored in non-volatile memory that is displayed in the BIOS splash screen	
Remote Wakeup/Remote Shutdown	System administrators can power on, restart, and power off a client computer from a remote location	
Instantly Available PC (Suspend to RAM - ACPI sleep state S3)	Allows for very low power consumption with quick resume time	
Remote System Installation via F12 (PXE 2.1) (Remote Boot from Server)	Allows a new or existing system to boot over the network and download software, including the operating system	
ROM revision levels	Reports the system BIOS revision level in Computer Configuration Utility (F10 Setup). Version is available through an industry standard interface (SMBIOS) so that management SW applications can use and report this information.	
System board revision level	Allows management SW to read revision level of the system board Revision level is digitally encoded into the HW and cannot be modified	
Start-up Diagnostics (Power-on Self-Test)	Assesses system health at boot time with selectable levels of testing	
Auto Setup when new hardware installed	System automatically detects the addition of new hardware	
Keyboard-less Operation	The system can be booted without a keyboard	
Localized ROM Setup	Common BIOS image supports System Configuration Utility (F10 Setup) menus in 12 languages with local keyboard mappings	
Asset Tag	Allows the user or MIS to set a unique tag string in non-volatile memor	
Per-slot Control	Allows I/O slot parameters (option ROM enable/disable, bus latency) to be configured individually	
Adaptive Cooling	Fan control parameters are set according to detected hardware configuration for optimal acoustics	
Pre-boot Diagnostics	Early (pre-video) critical errors are reported via beeps and blinks on the power LED	
Industry Standard Specification Support		
UEFI Specification Revision	2.3.1	
Industry Standard	Revision Supported by the BIOS	
ACPI	Advanced Configuration and Power Management Interface, Version 2.0	
ATA (IDE)	AT Attachment 6 with Packet Interface (ATA/ATAPI-6), Revision 3b	
CD Boot	"El Torito" Bootable CD-ROM Format Specification Version 1.0	
EDD	 Enhanced Disk Drive Specification Version 1.1 BIOS Enhanced Disk Drive Specification Version 3.0 	
EHCI	Enhanced Host Controller Interface for Universal Serial Bus, Revision 1.0	
PCI	 PCI Local Bus Specification, Revision 2.3 PCI Power Management Specification, Revision 1.1 PCI Firmware Specification, Revision 3.0, Draft 0.7 	
PCI Express	PCI Express Base Specification, Revision 2.0 PCI Express Base Specification, Revision 3.0	
РММ	POST Memory Manager Specification, Version 1.01	
SATA	 Serial ATA Specification, Revision 1.0a Serial ATA 3 Gb/s: Serial ATA Specification, Revision 2.5 Serial ATA 6 Gb/s: Serial ATA Specification, Revision 3.0 	
SPD	PC SDRAM Serial Presence Detect (SPD) Specification, Revision 1.2	



UHCI	Universal Host Controller Interface Design Guide, Revision 1.1
USB	Universal Serial Bus Revision 1.1 Specification
	Universal Serial Bus Revision 2.0 Specification
	Universal Serial Bus Revision 3.0 Specification
SMBIOS	System Management BIOS Reference Specification, Version 2.7

	onmental Responsibility
Eco-Label Certifications & Declarations	This product has received or is in the process of being certified to the following approvals and may be labeled with one or more of these marks:
	ENERGY STAR® (energy-saving features available on selected configurations-Windows only)
	 US Federal Energy Management Program (FEMP) China Energy Conservation Program IT ECO declaration
Batteries	The battery in this product complies with EU Directive 2006/66/EC Battery size: CR2032 (coin cell) Battery type: Lithium Metal
	The battery in this product does not contain:
	Mercury greater than 5ppm by weight
	 Cadmium greater than 10ppm by weight Lead greater than 40ppm by weight
Restricted Material Usage	This product meets the material restrictions specified in HP's General Specification for the Environment. http://www.hp.com/hpinfo/globalcitizenship/environment/pdf/gse.pdf Hewlett-Packard is committed to compliance with all applicable environmental laws and regulations, including the European Union Restriction of Hazardous Substances (RoHS) Directive
	HP's goal is to exceed compliance obligations by meeting the requirements of the RoHS Directive on a worldwide basis.
_	frhis product is low halogen except for power cords, cables and peripherals, as well as the following customer-configurable internal components: 3 ½" SAS HDDs, LSI 9260-8i SAS 6Gb/s ROC RAID Card, Creative Recon3D PCIe Audio Card, Liquid Cooling Solution and Broadcom 5761 Gigabit PCIe NIC are not Low Halogen. Service parts obtained after purchase may not be Low Halogen.
End-of-Life	Hewlett-Packard offers end-of-life HP product return and recycling programs in many geographic
Management and Recycling	areas. To recycle your product, please go to: http://www.hp.com/recycle or contact your nearest HP sales office. Products returned to HP will be recycled, recovered or disposed of in a responsible manner. This product is greater than 90% recyclable by weight when properly disposed of at end of life.
Hewlett-Packard	For more information about HP's commitment to the environment:
Corporate Environmental Information	Global Citizenship Report: http://www.hp.com/hpinfo/globalcitizenship/gcreport/index.html
	Eco-label certifications: http://www.hp.com/hpinfo/globalcitizenship/environment/productdesign/ecolabels.html
	ISO 14001 certificates: http://www.hp.com/hpinfo/globalcitizenship/environment/operations/envmanagement.html
Additional Information	This HP product is designed to comply with the Waste Electrical and Electronic Equipment (WEEE) Directive - 2002/96/EC. Plastics parts weighing over 25 grams used in the product are marked per ISO 11469 and
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Packaging	ISO1043. This product is >90% recycle-able when properly disposed of at end of life. EPEAT Gold registered in the U.S. EPEAT registration varies by country. See www.epeat.net for registration status by country HP Workstation product packaging meets the HP General Specification for the Environment at http://www.hp.com/hpinfo/globalcitizenship/society/gen_specifications.html
	 Does not contain restricted substances listed in HP Standard 011-1 General Specification for the Environment Does not contain ozone-depleting substances (ODS) Does not contain heavy metals (lead, mercury, cadmium or hexavalent chromium) in excess of 100 ppm sum total for all heavy metals listed Maximizes the use of post-consumer recycled content materials in packaging materials All packaging material is recyclable All packaging material is designed for ease of disassembly Reduced size and weight of packages to improve transportation fuel efficiency Plastic packaging materials are marked according to ISO 11469 and DIN 6120 standards formatting
Packaging Materials	Torridang
Internal	Cushions and plastic bags made of low density polyethylene (LDPE).
External	Outer carton, accessories carton, and insert made of corrugated paper board.

Manageability				
Industry Standard Specifications	This product meets the following industry standard specifications for manageability function • DASH 1.1 required functionalities via Intel LAN on motherboard			
Intel Active	Intel Active Management Technology (AMT) 7.0			
Management				
Technology (AMT)	An advanced set of remote management features and functionality providing IT administrators the latest and most effective tools to remotely discover, heal, and protect networked client systems regardless of the system's health or power state. AMT 7.0 includes the following advanced management functions:			
	Power Management (on, off, reset)			
	Hardware Inventory (includes BIOS and firmware revisions)			
	Hardware Alerting			
	Agent Presence			
	System Defense Filters			
	SOL/IDER			
	Cisco NAC/SDN Support			
	ME Wake-on-LAN			
	DASH 1.1 compliance			
	IPv6 Support			
	• Fast Call for Help - a client inside or outside the firewall may initiate a call for help via BIOS screen, periodic connections, or alert triggered connection			
	Remote Scheduled Maintenance - pre-schedule when the system connects to the IT or service provider console for maintenance.			
	Remote Alerts - automatically alert IT or service provider if issues arise			
	Access Monitor - Provides oversight into Intel® AMT actions to support security requirements			
	PC Alarm Clock			
	Microsoft NAP Support			
	Host Base set-up and configuration			
	Management Engine (ME) firmware roll back			



Intel® vPro™	The HP Z620 Workstation supports Intel vPro technology when configured as outlined below:		
Technology	The HP 2620 Workstation supports intervero technology when configured as outlined below.		
recimology	 Intel Xeon processor E5-1600 product family or E5-2600 product family featuring Intel vPro Technology Intel C602 chipset Intel 82579LM GbE LAN 		
Remote Manageability Software Solutions	The HP Z620 Workstation is supported on the following remote manageability software consoles: • LANDesk Management Suite (HP recommended solution) • Microsoft System Center Configuration Manager		
	HP Client Automation Enterprise For questions or support for manageability needs, please visit http://www.hp.com/go/easydeploy		
System Software Manager	For questions or support for SSM, please visit: http://www.hp.com/go/ssm		
Service, Support, and Warranty	On-site Warranty and Service (Note 1): Three-years, limited warranty and service offering delivers on-site, next business-day (Note 2) service for parts and labor and includes free telephone support (Note 3) 8am - 5pm. Global coverage (Note 2) ensures that any product purchased in one country and transferred to another, non-restricted country will remain fully covered under the original warranty and service offering.		
	NOTE 1: Terms and conditions may vary by country. Certain restrictions and exclusions apply. NOTE 2: On-site service may be provided pursuant to a service contract between HP and an authorized HP third-party provider, and is not available in certain countries. Global service response times are based on commercially reasonable best effort and may vary by country. NOTE 3: Technical telephone support applies only to HP-configured, HP and HP-qualified, third-party hardware and software. Toll-free calling and 24x7 support service may not be available in some countries.		
	HP Care Pack Services extend service contracts beyond the standard warranties. Service starts from date of hardware purchase. To choose the right level of service for your HP product, use the HP Care Pack Services Lookup Tool at: http://www.hp.com/go/lookuptool. Additional HP Care Pack Services information by product is available at: http://www.hp.com/hps/carepack. Service levels and response times for HP Care Packs may vary depending on your geographic location.		
Product Change Notification	 Program to proactively communicate Product Change Notifications (PCNs) and Customer Advisories by email to customers, based on a user-defined profile. PCNs provide advance notification of hardware and software changes to be implemented in the factory providing time to plan for transition. Customer Advisories provide concise, effective problem resolution, greatly reducing the 		
	need to call technical support.		



Stable & Consistent Offerings

As part of its commitment to hardware, software, and solution innovation, HP is proud to introduce this breakthrough platform configuration stability to HP Workstation customers. HP Stable & Consistent Offerings are built on the foundation of a carefully chosen set of hardware and software designed and tested to work with all HP Z Workstation platforms through their end of life. These components and their corresponding HP Workstation platform compatibility are outlined in this section.

HP Stable & Consistent Offerings are available worldwide to all HP Workstation customers-no special programs, no additional cost-no kidding. Simply select your hardware and software components when you customize your HP Workstation and be assured that you'll be able to buy that same configuration throughout the lifecycle of the product.

Processors	Product #	Offering		
	A2A06AV	Intel Xeon E5-2620 2 15M 1333 6C 1 CPU		
	A2A19AV	Intel Xeon E5-2620 2 15M 1333 6C 2 CPU		
	A2A09AV	Intel Xeon E5-2643 3.3 10M 1600 4C 1 CPU		
	A2A22AV	Intel Xeon E5-2643 3.3 10M 1600 4C 2 CPU		
Hard Drives	Product #	Offering		
	QG001AV	500GB 7200 RPM SATA 1st HDD		
	QG011AV	500GB 7200 RPM SATA 2nd HDD		
	QG021AV	500GB 7200 RPM SATA 3rd HDD		
	QG031AV	500GB 7200 RPM SATA 4th HDD		
	QG002AV	1TB 7200 RPM SATA 1st HDD		
	QG012AV	1TB 7200 RPM SATA 2nd HDD		
	QG022AV	1TB 7200 RPM SATA 3rd HDD		
	QG032AV	1TB 7200 RPM SATA 4th HDD		
Graphics	Product #	Offering		
	A7U49AV	NVIDIA NVS 310 512MB GFX		
	A7U50AV	NVIDIA NVS 310 512MB 2nd GFX		
	A7U51AV	NVIDIA NVS 310 512MB 3rd GFX		
	A7U52AV	NVIDIA NVS 310 512MB 4th GFX		
	C2J48AV	NVIDIA Quadro K2000 2GB Graphics		
	C2J49AV	NVIDIA Quadro K2000 2GB Graphics		
Memory	Product #	Offering		
		Any configuration with 2GB DDR3-1866 ECC Unbuffered DIMMs		
		Any configuration with 4GB DDR3-1866 ECC Unbuffered DIMMs		
		Any configuration with 4GB DDR3-1866 ECC Registered DIMMs		
		Any configuration with 4GB DDR3-1866 ECC Registered DIMMs Any configuration with 8GB DDR3-1866 ECC Registered DIMMs		
Optical and Remo	vableProduct#			

QG053AV

16x SuperMulti DVDRW SATA 2nd ODD

Stable & Consistent Offerings

Input Devices	Product # A8Z53AV	Offering HP USB Keyboard (available June 2012)
	A8Z55AV	HP USB Optical Mouse (available June 2012)
Operating Systems	Product #	Offering
	LJ454AV	Windows 7 Professional 64-bit OS



Technical Specifications - Processors

Processors Intel® Xeon® Processor E5-2620 6C 2.00GHz

Intel® Xeon® Processor E5-2643 4C 3.30GHz

Introduction

The Intel® Xeon® processor E5-1600/E5-2600/E5-26000 product families are the next generation of 64-bit, multi-core enterprise processors built on 32-nanometer process technology. Throughout this document, the Intel® Xeon® processor E5-1600/E5-2600/E5-4600 product families may be referred to as simply the processor. Where information differs between the EP and EP 4S SKUs, this document uses specific Intel® Xeon® processor E5-1600 product family, Intel® Xeon® processor E5-2600 product family, and Intel® Xeon® processor E5-4600 product family notation.Based on the low-power/high performance 2nd Generation Intel® Core™ Processor Family microarchitecture, the processor is designed for a two chip platform consisting of a processor and a Platform Controller Hub (PCH) enabling higher performance, easier validation, and improved x-y footprint. The Intel® Xeon® processor E5-1600 product family and the Intel® Xeon® processor E5-2600 product family are designed for Efficient Performance server, workstation and HPC platforms. The Intel® Xeon® processor E5-4600 product family processor supports scalable server and HPC platforms of two or more processors, including "glueless" 4-way platforms. Note: some processor features are not available on all platforms.

These processors feature per socket, two Intel® QuickPath Interconnect point-to-point links capable of up to 8.0 GT/s, up to 40 lanes of PCI Express* 3.0 links capable of 8.0 GT/s, and 4 lanes of DMI2/PCI Express* 2.0 interface with a peak transfer rate of 5.0 GT/s. The processor supports up to 46 bits of physical address space and 48-bit of virtual address space. Included in this family of processors is an integrated memory controller (IMC) and integrated I/O (IIO) (such as PCI Express* and

Performance and Features

- Up to 8 execution cores
- Each core supports two threads (Intel® Hyper-Threading Technology), up to 16 threads per socket

DMI2) on a single silicon die. This single die solution is known as a monolithic processor.

- 46-bit physical addressing and 48-bit virtual addressing
- 1 GB large page support for server applications
- A 32-KB instruction and 32-KB data first-level cache (L1) for each core
- A 256-KB shared instruction/data mid-level (L2) cache for each core
- Up to 20 MB last level cache (LLC): up

Intel® Xeon® Processor E5-1620 4C 3.60GHz Intel® Xeon® Processor E5-1603 4C 2.80GHz

Processor Note

For detailed processor specifications, please refer to the Overview section at the beginning of this document.

Z620 Xeon E5-2620 6C 2.00 15MB 1333 CPU2 Z620 Xeon E5-2643 4C 3.30 10MB 1600 CPU2

A6S74AA

A6S77AA

Introduction

The After Market Option kits for the Z620 processors include the "2nd CPU & Memory Module", the Intel Xeon processor, and the heatsink. Additional system memory must be ordered separately.



Technical Specifications - Processors

Intel® Xeon® Processor E5-2603 v2 4C 1.80GHz Intel® Xeon® Processor E5-2609 v2 4C 2.50GHz Intel® Xeon® Processor E5-2620 v2 6C 2.10GHz Intel® Xeon® Processor E5-2630 v2 6C 2.60GHz Intel® Xeon® Processor E5-2637 v2 4C 3.50GHz Intel® Xeon® Processor E5-2640 v2 8C 2.00GHz Intel® Xeon® Processor E5-2640 v2 8C 2.00GHz Intel® Xeon® Processor E5-2643 v2 6C 3.50GHz Intel® Xeon® Processor E5-2650 v2 8C 2.60GHz Intel® Xeon® Processor E5-2660 v2 10C 2.20GHz Intel® Xeon® Processor E5-2667 v2 8C 3.30GHz Intel® Xeon® Processor E5-2667 v2 10C 2.50GHz Intel® Xeon® Processor E5-2670 v2 10C 2.50GHz Intel® Xeon® Processor E5-2690 v2 10C 3.00GHz Intel® Xeon® Processor E5-2695 v2 12C 2.40GHz Intel® Xeon® Processor E5-2695 v2 12C 2.40GHz Intel® Xeon® Processor E5-2697 v2 12C 2.70GHz

Intel® Xeon® Processor E5-1607 v2 4C 3.00GHz Intel® Xeon® Processor E5-1620 v2 4C 3.70GHz Intel® Xeon® Processor E5-1650 v2 6C 3.50GHz Intel® Xeon® Processor E5-1660 v2 6C 3.70GHz Intel® Xeon® Processor E5-1680 v2 8C 3.00GHz

Z620 Xeon E5-2603 v2 4C 1.80 10MB 1333 CPU2
Z620 Xeon E5-2609 v2 4C 2.50 10MB 1333 CPU2
Z620 Xeon E5-2620 v2 6C 2.10 15MB 1600 CPU2
Z620 Xeon E5-2630 v2 6C 2.60 15MB 1600 CPU2
Z620 Xeon E5-2637 v2 4C 3.50 15MB 1866 CPU2
Z620 Xeon E5-2640 v2 8C 2.00 20MB 1600 CPU2
Z620 Xeon E5-2640 v2 8C 2.00 20MB 1600 CPU2
Z620 Xeon E5-2643 v2 6C 3.50 25MB 1866 CPU2
Z620 Xeon E5-2650 v2 8C 2.60 20MB 1866 CPU2
Z620 Xeon E5-2660 v2 10C 2.20 25MB 1866 CPU2
Z620 Xeon E5-2667 v2 8C 3.30 25MB 1866 CPU2
Z620 Xeon E5-2670 v2 10C 2.50 25MB 1866 CPU2
Z620 Xeon E5-2680 v2 10C 2.80 25MB 1866 CPU2
Z620 Xeon E5-2690 v2 10C 3.00 25MB 1866 CPU2
Z620 Xeon E5-2690 v2 10C 3.00 25MB 1866 CPU2
Z620 Xeon E5-2697 v2 12C 2.40 30MB 1866 CPU2
Z620 Xeon E5-2697 v2 12C 2.70 30MB 1866 CPU2

E3E04AA E3E05AA E3E06AA E3E07AA E3E08AA E3E10AA E3E11AA E3E12AA E3E14AA E3E15AA E3E15AA

E3E18AA

Technical Specifications - Hard Drives

HP SAS (Serial Attached SCSI) Hard **Drives for HP** Workstations

600GB SAS 15K rpm 6Gb/s 3.5" HDD

Capacity 600GB 1 in; 2.54 cm Height

Width **Media Diameter** 3.5 in; 8.9 cm **Physical Size** 4 in; 10.17 cm

Interface SAS 6.0 Gb/s Synchronous Transfer

Rate (Maximum)

Buffer 16 MB

Seek Time (typical Single Track 0.2 ms reads, includes controller Average 3.4 ms overhead, including **Full Stroke** 6.6 ms settling)

Rotational Speed 15,000 rpm

Logical Blocks 1,172,123,568 - 512 byte blocks

Operating Temperature 50° to 95° F (10° to 35° C)

450GB SAS 15K rpm 6Gb/s 3.5" HDD

450GB Capacity Height 1 in; 2.54 cm

Width **Media Diameter** 3.5 in; 8.9 cm **Physical Size**

SAS

4 in; 10.17 cm

Interface **Synchronous Transfer** 6Gb/s

Rate (Maximum)

Buffer 16MB

Seek Time (typical Single Track 0.2 ms reads, includes controller Average 3.4 ms overhead, including **Full Stroke** 6.6 ms settling)

15,000 rpm **Rotational Speed**

Operating Temperature 50° to 95° F (10° to 35° C)

300GB SAS 15K rpm 6Gb/s 3.5" HDD

300GB Capacity Height 1 in; 2.54 cm

Width **Media Diameter** 3.5 in; 8.9 cm **Physical Size** 4 in; 10.17 cm

Interface SAS Synchronous Transfer 6Gb/s

Rate (Maximum)

Buffer 16MB

Single Track Seek Time (typical 0.2 ms reads, includes controller Average 3.4 ms overhead, including **Full Stroke** 6.6 ms settling)

15,000 rpm **Rotational Speed**

Operating Temperature 50° to 95° F (10° to 35° C)

Technical Specifications - Hard Drives

HP 300GB SAS 10K SFF HDD

300GB Capacity

Height 0.6 in; 1.53 cm

Width **Media Diameter** 2.5 in; 6.36 cm

> **Physical Size** 2.75 in; 6.99 cm

Interface SAS 6Gb/s Up to 600MB/s **Synchronous Transfer**

Rate (Maximum)

Buffer 64MB

Cache multi-segmentable cache buffer

Seek Time (typical **Single Track** 0.4 ms (max) reads, includes controller **Average** 3.6 ms

overhead, including

Full Stroke 7.3 ms settling)

Rotational Speed 10,000 rpm 585,937,500 **Logical Blocks**

Operating Temperature41° to 131° F (5° to 55° C)

HP 600GB SAS 10K SFF HDD

Capacity 600GB

Height 0.6 in; 1.53 cm

Width **Media Diameter** 2.5 in; 6.36 cm

> **Physical Size** 2.75 in; 6.99 cm

Interface SAS 6Gb/s **Synchronous Transfer** Up to 600MB/s

Rate (Maximum)

Buffer 64MB

Cache multi-segmentable cache buffer

Seek Time (typical Single Track 0.4 ms (max) reads, includes controller **Average** 3.6 ms overhead, including **Full Stroke** 7.3 ms settling)

Rotational Speed 10,000 rpm **Logical Blocks** 1,172,123,568

Operating Temperature41° to 131° F (5° to 55° C)

HP 900GB SAS 10K SFF HDD

Capacity 900GB

Height 0.6 in; 1.53 cm

Width **Media Diameter** 2.5 in; 6.36 cm

Physical Size 2.75 in; 6.99 cm

Interface SAS 6Gb/s **Synchronous Transfer** Up to 600MB/s

Rate (Maximum)

Buffer 64MB

Cache multi-segmentable cache buffer Single Track Seek Time (typical 0.2ms (max) reads, includes controller **Average** 3.5ms overhead, including 7.0ms

Full Stroke settling)

Technical Specifications - Hard Drives

Rotational Speed 10,000 rpm **Logical Blocks** 1,758,174,767

Operating Temperature41° to 131° F (5° to 55° C)

HP 1.2TB SAS 10K SFF Capacity 1.2TB

HDD

Height 0.6 in; 1.53 cm

Width Media Diameter 2.5 in; 6.36 cm

Physical Size 2.75 in; 6.99 cm

3.5ms

Interface SAS 6Gb/s
Synchronous Transfer Up to 600MB/s

Rate (Maximum)

Buffer 64MB

Seek Time (typical Single Track 0.18ms (max)

reads, includes controller Average

overhead, including settling)

Full Stroke 7.17ms

Rotational Speed 10,000 rpm Logical Blocks 2,344,225,968

Operating Temperature41° to 131° F (5° to 55° C)

SATA (Serial ATA) Hard250GB SATA 10K rpm

Drives for HP Workstations

SFF HDD

Capacity 250GB

Height 0.6 in; 1.53 cm

Width Media Diameter 2.5 in; 6.36 cm
Physical Size 2.75 in; 6.99 cm

2.70 m,

Interface Serial ATA (6Gb/s)

Synchronous Transfer Up to 600MB/s

Rate (Maximum)

Buffer 64MB Cache Adaptive

Seek Time (typical Single Track 1.2ms (typical)

reads, includes controller

overhead, including

Average 3.6ms

settling) Full Stroke 9.0ms (typical)

Rotational Speed 10K rpm

Operating Temperature41° to 131° F (5° to 55° C)

500GB SATA 10K rpm

SFF HDD

Capacity 500GB

Height 0.6 in; 1.53 cm

Width Media Diameter 2.5 in; 6.36 cm

Physical Size 2.75 in; 6.99 cm

Interface Serial ATA (6Gb/s)

Synchronous Transfer Up to 600MB/s

Rate (Maximum)

Buffer 64MB Cache Adaptive

Technical Specifications - Hard Drives

Single Track Seek Time (typical 1.2ms (typical) reads, includes controller Average

3.6ms overhead, including

Full Stroke 9.0ms (typical) settling)

10K rpm **Rotational Speed**

Operating Temperature41° to 131° F (5° to 55° C)

1TB SATA 10K rpm SFF HDD

1TB Capacity

Height 0.6 in; 1.53 cm

Width **Media Diameter** 2.5 in; 6.36 cm

> **Physical Size** 2.75 in; 6.99 cm

> > 3.6ms

Interface Serial ATA (6Gb/s) Up to 600 MB/s Synchronous Transfer

Rate (Maximum)

Buffer 64MB Cache Adaptive

Seek Time (typical Single Track 1.2ms (typical)

reads, includes controller Average overhead, including

Full Stroke 9.0ms (typical) settling)

Rotational Speed 10K rpm

Operating Temperature41° to 131° F (5° to 55° C)

500GB SATA 7200 rpm Capacity 6Gb/s 3.5" HDD

500GB

Height 0.6 in; 1.53 cm

Width **Media Diameter** 3.5 in; 8.9 cm

Physical Size 4 in; 10.17 cm

Interface Serial ATA (6.0Gb/s), NCQ enabled

Synchronous Transfer Up to 600MB/s

Rate (Maximum)

Buffer 16MB

Cache Segmentable

Seek Time (typical Single Track 2 ms reads, includes controller Average 11 ms overhead, including **Full-Stroke** 21 ms

settling) **Rotational Speed** 7,200 rpm

Logical Blocks 976,773,168

Operating Temperature41° to 131° F (5° to 55° C)

1TB SATA 7200 rpm 6Gb/s 3.5" HDD

Capacity 1 Terabyte (1000 GB)

Height 1 in; 2.54 cm

Width **Media Diameter** 3.5 in; 8.9 cm

Physical Size 4 in; 10.17 cm

Interface Serial ATA (6.0Gb/s), NCQ enabled

Synchronous Transfer Up to 600 MB/s

Rate (Maximum)



Technical Specifications - Hard Drives

Cache 32 MB

Seek Time (typical **Single Track** 2 ms reads, includes controller **Average** 11 ms overhead, including **Full-Stroke** 21 ms

Rotational Speed 7,200 rpm Logical Blocks 1,953,525,168

Operating Temperature41° to 131° F (5° to 55° C)

2.0TB SATA 7200 rpm 6Gb/s 3.5" HDD

2TB Capacity

1 in; 2.54 cm Height

Width **Media Diameter** 3.5 in; 8.9 cm

> Physical Size 4 in; 10.17 cm

Interface Serial ATA (6.0 Gb/s), NCQ Enabled

Synchronous Transfer Up to 600 MB/s

Rate (Maximum)

settling)

Cache 64MB

Seek Time (typical **Single Track** 2 ms reads, includes controller Average 11 ms overhead, including **Full-Stroke** 21 ms settling)

Rotational Speed 7,200 rpm **Logical Blocks** 3,907,029,168

Operating Temperature41° to 131° F (5° to 55° C)

3.0TB SATA 7200 rpm 6Gb/s 3.5" HDD

3.0TB Capacity Height

1 in; 2.54 cm Width **Media Diameter**

3.5 in; 8.9 cm **Physical Size** 4 in; 10.17 cm

Interface Serial ATA (6.0Gb/s), NCQ enabled

Synchronous Transfer Up to 6.0 Gb/s

Rate (Maximum)

Buffer 64MB

Seek Time (typical **Single Track** 0.6 ms reads, includes controller Average 11 ms

overhead, including

Full-Stroke Not specified settling)

Rotational Speed 7200 rpm

Operating Temperature41° to 140° F (5° to 60° C)

500GB SATA 7.2K SED Capacity

SFF HDD

500GB

Height 0.275 in; 0.7 cm

Width **Media Diameter** 2.5 in; 6.36 cm 2.75 in; 6.99 cm

Physical Size Serial ATA (6Gb/s)

Interface Synchronous Transfer Up to 600MB/s

Rate (Maximum)

Technical Specifications - Hard Drives

Buffer 32MB

Seek Time (typical **Single Track** 1 ms reads, includes controller Average 4.2 ms

overhead, including settling)

Full-Stroke

25 ms (typical)

2.5 in; 6.36 cm

Rotational Speed 7,200 rpm

Operating Temperature 32° to 140° F (0° to 60° C)

(SSDs) for Workstations

HP Solid State Drives HP 128GB SATA 6Gb/s Capacity

128GB

Height 0.28 in; 0.7 cm

Width **Physical Size**

Interface SATA 6Gb/s

Synchronous Transfer Up to 500MB/s (Sequential Read)

Rate (Maximum)

Operating Temperature 32° to 158° F (0° to 70° C)

HP 256GB SATA 6Gb/s Capacity

SSD

SSD

256GB

Height 0.28 in; 0.7 cm SATA 6Gb/s Interface

Synchronous Transfer Up to 500MB/s (Sequential Read)

Rate (Maximum)

Operating Temperature 32° to 158° F (0° to 70° C)

HP 256GB SATA 6Gb/s Capacity

SED SSD

256GB

Height 0.28 in; 0.7 cm

Width **Physical Size** 2.5 in; 6.36 cm

Interface 6Gb/s SATA

Synchronous Transfer Up to 500MB/s (Sequential Read)

Rate (Maximum)

Operating Temperature 32° to 158° F (0° to 70° C)

HP 512GB SATA 6Gb/s Capacity

SSD

512GB

Height 0.28 in; 0.7 cm

Width **Physical Size** 2.5 in; 6.36 cm

Interface 6Gb/s SATA

Synchronous Transfer Up to 500MB/s (Sequential Read)

Rate (Maximum)

Operating Temperature 32° to 158° F (0° to 70° C)

Intel Pro 1500 180GB

SATA SSD

Capacity 180GB

Width **Physical Size** 2.5 in; 6.36 cm

Interface 6Gb/s SATA Synchronous Transfer 600 Mb/s

Rate (Maximum)

Technical Specifications - Hard Drives

Samsung SM843T Capacity 240GB

240GB SATA SSD Width Physical Size 2.5 in; 6.36 cm

Interface SATA 6Gb/s **Synchronous Transfer** Up to 600MB/s

Rate (Maximum)

Operating Temperature 32° to 158° F (0° to 70° C)

Samsung SM843T Capacity 480GB

480GB SATA SSD Width Physical Size 2.5 in; 6.36 cm

Interface SATA 6Gb/s **Synchronous Transfer** Up to 600MB/s

Rate (Maximum)

Operating Temperature 32° to 158° F (0° to 70° C)

PCIe SSDs for HP Fusion ioFX 410GB Capacity 410GB

Workstations PCIe Accelerator Interface PCI Express 2.0 x4 electrical x4 physical

Operating Temperature32° to 95° F (0° to 35° C)

Technical Specifications - Hard Drive Controllers

LSI 9217-4i4e 8-port SAS 6Gb/s RAID Card

PCI Bus 8 lanes, PCI Express 3.0

RAID Levels Offers Integrated RAID (0, 1, 1E and 10)

PCI Data Burst Half Duplex x8, PCIe, 8000 MB/s
Transfer Rate

SAS Bandwidth Half Duplex 600 MB/s per lane

PCI Card Type 3.3V Add-in Card PCI Voltage 12 V ± 10%

PCI Power 9.8W typical, Airflow min 200 LFM

Bracket Full height and low profile
Certification Level PCI Express 3.0 compliant
SAS Processor LSI SAS2308/ Fusion MPT 2.0
Internal Connectors One x4 internal mini-SAS (SFF8087)
External Connectors One x4 external mini-SAS (SFF8088)
Maximum Number of 256 Non-RAID SAS/SATA devices

Maximum Number o SCSI Devices

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LED Indicators N/A

LSI 9270-8i SAS 6Gb/s PCI Bus ROC RAID Card and iBBU9 Battery Backup Unit POLO

PCI Bus x8 lane PCIe 3.0 compliant

RAID Levels RAID 0, 1, 5, and 6

RAID spans 10, 50 and 60

PCI Card TypeLow profile, single PCIe slot design with full height bracket.

PCI Voltage +3.3V Add-in Card
PCI Power +3.3V, +12V

Certification Level PCI-Express 3.0

IO Bus Eight 6Gb/s and 3Gb/s compatible SAS/SATA ports

SAS Processor LSISAS2208 Dual-Core RAID on Chip (ROC)

Internal Connectors Two SAS SFF8087 x4 (Mini-SAS)

External Connectors None

Maximum Number of Up to 128 SAS and/or SATA hard drives and SSDs

SCSI Devices NOTE: HP Workstations do not support this many internal drives.

LED Indicators Heartbeat LED on card



Technical Specifications - Graphics

NVIDIA NVS 310 512MB Form Factor Low Profile:

Graphics

2.713 inches in height × 6.150 inches in length

Weight: ~142 grams

Graphics Controller NVIDIA NVS 310

GPU: GF119-825

Bus Type PCI Express x16, 2.0 compliant

Memory Size: 512MB DDR3

Clock: 875Mhz

Memory Bandwidth: 14GB/s

Connectors 2 x DisplayPort

Maximum Resolution Up to 2560 x 1600 (digital display) per display. **Image Quality Features** The following video formats are supported:

- MPEG2

- MPEG4 Part 2 Advanced Simple Profile

H.264 SVC codec supportSupport for 3D Blu Ray

- VC1

- DivX version 3.11 and later

- MVC

A full range of video resolutions are supported including 1080p, 1080i, 720p, 480p and 480i. The NVS 310 GPU provides hardware acceleration for the computationally intensive parts of video processing, as well as provides improved video playback speeds via faster decode and transcode.

Display Output

Up to 2 displays in the following configurations:

DisplayPort output:

- Drives two DisplayPort enabled digital display at resolutions up to 2560 × 1600 at 60 Hz with reduced blanking, when connected natively using the 2 DisplayPort connectors on the NVS 310 graphics card
- Supports 2 monitors up to resolution of 1920 × 1200 at 60 Hz with reduced blanking using DisplayPort 1.2 multi stream topology technology.

DVI-D output:

- Drives two digital display at resolutions up to 1920 × 1200 at 60
 Hz with reduced blanking using DisplayPort to DVI-D single-link
 cable adaptors
- Drives two digital display at resolutions up to 2560× 1600 at 60 Hz with reduced blanking using DisplayPort to DVI-D dual-link cable adaptors

HDMI output:

 NVS 310 is capable of driving two high definition (HD) panels up to resolutions of 1920 × 1080P at 60 Hz using DisplayPort to HDMI cable adaptors

VGA display output:

•



Technical Specifications - Graphics

Drives two analog display at resolutions up to 1920 × 1200 at 60
 Hz using DisplayPort to VGA cable adaptors

Shading Architecture Supported Graphics

e Shader Model 5.0 DX11, OpenGL 4.1

APIs

Available Graphics

Drivers

Windows 8

Genuine Windows 7 Professional (64-bit and 32-bit) Microsoft Windows XP Professional (64-bit and 32-bit)

Red Hat Enterprise Linux(RHEL)

SUSE Linux Enterprise Desktop 11 (64-bit and 32-bit)

HP qualified drivers may be preloaded or the latest HP qualified drivers

are available from the HP support Web site:

http://welcome.hp.com/country/us/en/support.html

SUSE Linux Enterprise drivers may also be obtained from: ftp://download.nvidia.com/novell or http://www.nvidia.com

Power Consumption

Note

19.5 Watts

1. The thermal solution used on this card is an active fan heatsink.

2. Factory configured NVS 310 graphics card have no cable adpaters

included. Adapters must be ordered separately.

3. Option kit NVS 310 includes 2 DP to DVI-D cable adapters.

NVIDIA NVS 315 1GB Graphics (for HP Workstations) Form Factor Low Profile:

2.713 inches in height × 5.7 inches in length

Weight: ~142 grams

Graphics Controller NVIDIA NVS 315 (using GF119-825 GPU)

Number of Cores: 48 CUDA cores

Max. Power: 19.3W

Cooling Solution: Active fan heatsink

Bus Type PCI Express x16, 2.0 compliant

Memory Size: 1GB DDR3

Clock: 875Mhz

Memory Bandwidth: 14GB/s

Connectors DMS-59 output

Cables included:

- For CTO: DMS-59 to DVI cable

- For AMO: DMS-59 to DVI cable and DMS-59 to VGA cable

Maximum Resolution Maximum number of displays supported: 2

Maximum Resolution Support:

DMS-59 to VGA: 2048 x 1536 @ 85Hz
 DMS-59 to DVI: 1980 x 1200 @ 60Hz
 DMS-59 to DP: 2560 x 1600 @ 60Hz

Image Quality Features See Display Output section.

The following video formats are supported:

- MPEG2

- MPEG4 Part 2 Advanced Simple Profile

- H.264 SVC codec support

- Support for 3D Blu Ray

- VC1



Technical Specifications - Graphics

- DivX version 3.11 or later

A full range of video resolutions are supported including 1080p, 1080i,

720p, 480p and 480i. The NVS 315 GPU provides hardware

acceleration for the computationally intensive parts of video processing, as well as provides improved video playback speeds via faster decode

and transcode.

Display Output Up to 2 displays using one of the following DMS-59 cables:

DMS-59 to DVI DMS-59 to VGA DMS-59 to DP

DisplayPort output:

- Drives two DisplayPort enabled digital displays at resolutions up to 2560 × 1600 at 60 Hz with reduced blanking, when connected via the

DMS-59 to DP adapter.

DVI-D output:

- Drives two digital display at resolutions up to 1920 × 1200 at 60 Hz with reduced blanking using DMS-59 to DVI-D single-link cable adaptor

VGA display output:

- Drives two analog display at resolutions up to 2048 × 1536 at 85 Hz

using DMS-59 to VGA cable adaptor.

Shading Architecture

Supported Graphics

APIs

Shader Model 5.0

DX11, OpenGL 4.3

Available Graphics

Drivers

Windows 8

Microsoft Windows 7 Professional (64-bit and 32-bit)

Microsoft Windows XP Professional (64-bit and 32-bit)

Red Hat Enterprise Linux(RHEL)

SUSE Linux Enterprise Desktop 11 (64-bit and 32-bit)

HP qualified drivers may be preloaded or the latest HP qualified drivers

are available from the HP support Web site:

http://welcome.hp.com/country/us/en/support.html

SUSE Linux Enterprise drivers may also be obtained from: ftp://download.nvidia.com/novell or http://www.nvidia.com

Notes

1. The thermal solution used on this card is an active fan heatsink.

2. Factory configured graphics card includes DMS-59 to DVI cable.

3. Option kit graphics card includes DMS-59 to DVI and DMS-59 to VGA

cables (one each).

NVIDIA NVS 510 2GB

Graphics

Form Factor Low Profile, 2.713 inches × 6.3 inches, single slot

Graphics Controller NVS 510 GPU

Core Clock: 797 Mhz Memory Clock: 891 Mhz

CUDA Cores: 192

Bus Type PCI Express x16, Generation 2.0

Memory 2GB DDR3

Technical Specifications - Graphics

Connectors Four mini-DisplayPort.

Four mini-DisplayPort to DisplayPort adapters included.

(DisplayPort to DVI-D, DisplayPort to VGA, DisplayPort to HDMI, and

DisplayPort to Dual-Link DVI adapters available as separate

accessories)

Maximum Resolution Mini-DisplayPort connectors support ultra-high-resolution panels (up to

3840 x 2160 @ 60Hz)

NOTE: This card supports up to four displays. For Windows XP, only 2

active displays are supported.

Image Quality Features 10-bit internal display processing, including hardware support for 10-bit

scan-out

Display Output DisplayPort with Multi-Stream Technology (MST) and High Bit Rate 2

(HBR2) support.

Digital Display Support

1. DisplayPort Output

- Drives four DisplayPort enabled digital display at resolutions up to 3840 × 2160 at 60 Hz with reduced blanking, when connected natively using the 4 DisplayPort connectors on the NVS 510 graphics card.

- DisplayPort Multi-Stream Topology (MST) Technology: Supports various combinations of display resolutions and number of displays when using DisplayPort multi stream topology technology - up to a maximum of 4 monitors at a resolution of 1920 × 1200 at 60 Hz with reduced blanking.

2. DVI-D Output

- Drives four digital displays at resolutions up to 1920 × 1200 at 60 Hz with reduced blanking using DisplayPort to DVI-D single-link cable adaptors.

- Drives four digital displays at resolutions up to 2560× 1600 at 60 Hz with reduced blanking using DisplayPort to DVI-D dual-link cable adaptors.

3. HDMI Output

- The NVS 510 graphics board is capable of driving four high definition (HD) panels up to resolutions of 1920 × 1080P at 60 Hz using DisplayPort to HDMI cable adaptors.

Analog Display Support

1. VGA display output

- Drives four analog displays at resolutions up to 1920 × 1200 at 60 Hz

using DisplayPort to VGA cable adaptors.

Supported Graphics **APIs**

Full Microsoft DirectX 11, Shader Model 5.0 support

Full OpenGL 4.3 support

Available Graphics Drivers

Genuine Windows 7 Professional (64-bit and 32-bit) Microsoft Windows XP Professional (64-bit and 32-bit) Red Hat Enterprise Linux(RHEL) 6 Desktop/Workstation SUSE Linux Enterprise Desktop 11 (64-bit and 32-bit)

HP qualified drivers may be preloaded or available from the HP support

Web site:

http://welcome.hp.com/country/us/en/support.html



Technical Specifications - Graphics

Power Consumption

33.4 Watts

Note

Heatsink cooler design is active.

Graphics Cable Adapters

Note Graphics Cable Adapter option choice is available starting Feb 1 2013

for the following graphics cards:

NVS 310, Quadro 410, Qaudro K5000, FirePro V3900, FirePro W7000

New Graphics Cards introduced after Feb 1 2013 will be eligible for choosing Graphics Cable Adapters, unless otherwise specified.

No cable choice for NVS 300, NVS 510.

Maximum number of cables allowed is 8.

NVIDIA Quadro 410 512MB Graphics

Form Factor Low Profile:

2.713 inches × 5.7 inches, single slot

Graphics Controller NVIDIA Quadro 410

GPU: GK107

Bus Type PCI Express x16, 3.0 compliant

Memory Size: 512MB DDR3

Clock: 900MHz

Memory Bandwidth: 14GB/s

Connectors One dual-link DVI-I connector

One DisplayPort connector

Maximum Resolution VGA (through DVI to VGA cable):

2048 × 1536 × 32 bpp at 85 Hz

Dual-link DVI

2560 × 1600 × 32 bpp at 60 Hz (reduced blanking)

Single-link DVI

• 1920 × 1200 × 32 bpp at 60 Hz (reduced blanking)

DisplayPort 1.2

3840 × 2160 × 36 bpp at 60 Hz

RAMDAC

400 MHz integrated RAMDAC

Display Output

Maximum number of displays supported: 2

Shading Architecture

Shader Model 5.0

Supported Graphics

DX11, OpenGL 4.2

APIs

Available Graphics

Windows 8

Drivers

Genuine Windows 7 Professional (64-bit and 32-bit) Microsoft Windows XP Professional (64-bit and 32-bit)

Red Hat Enterprise Linux(RHEL)

SUSE Linux Enterprise Desktop 11 (64-bit and 32-bit)

HP qualified drivers may be preloaded or the latest HP qualified drivers

are available from the HP support Web site:

Technical Specifications - Graphics

http://welcome.hp.com/country/us/en/support.html

SUSE Linux Enterprise drivers may also be obtained from: ftp://download.nvidia.com/novell or http://www.nvidia.com

Notes 1. Factory configured Quadro 410 does not include any video adapters.

Adapters must be ordered separately.

2. Option kit Quadro 410 includes one DP to DVI-D adapter

NVIDIA Quadro K600 1GB Graphics **Form Factor** 2.731" H x 6.3" L

Single Slot, Low Profile

Full Height Profile bracket installed Low Profile bracket included

Graphics Controller NVIDIA Quadro K600 Graphics Card

Kepler GK107 GPU 192 CUDA cores Max Power: 41 Watts PCI Express 2.0 x16

Bus Type PCI Express 2.0 x16

Memory 1 GB GDDR3, 891 Mhz
128-bit memory I/O path

29 GB/s memory bandwidth

Connectors 1 DL-DVI(I) output, 1 DisplayPort output

CTO: No video cable adapter included

AMO: One DP-to-DVI adapter included with card

Additional DVI-to-VGA, DisplayPort-to-VGA or DisplayPort-to-DVI

adapters are available as accessories

Maximum Resolution DisplayPort:

- up to 3840 x 2160 x 30 bpp @ 60Hz

- supports High Bit Rate 2 (HBR2) and Multi-Stream Transport (MST)

DL-DVI(I) output:

- up to 2560 x 1600 x 32 bpp @ 60Hz

Image Quality Features 10-bit internal display processing pipeline

10-bit scan-out support

Display Output VGA:

- requires use of DVI-to-VGA and/or DP-to-VGA video cable adapters

- 400 Mhz integrated RAMDAC

- Max resolution: 2048 x 1536 x 32 bpp @ 85 Hz

DL-DVI(I):

- Max resolution: 2560 x 1600 x 32 bpp @ 60 Hz

SL-DVI(I):

- Max resolution: 1920 x 1200 x 32 bpp @ 60 Hz

DisplayPort:

- Supports HBR2 and MST

- Max resolution: 3840 x 2160 x 30 bpp @ 60 Hz (only one monitor can

be connected to the Quadro K600 DisplayPort connector at this

resolution)

- Max number of daisy-chained monitors: 2

Shading Architecture Full Microsoft DirectX 11 Shader Model 5.0

Technical Specifications - Graphics

Supported Graphics

APIs

OpenGL 4.3 DirectX 11

API support includes:

CUDA C, CUDA C++, DirectCompute 5.0, OpenCL, Java, Python, and

Fortran

Available Graphics

Drivers

Windows 8 Pro 64-bit Windows 8 (China) 64-bit

Genuine Windows 7 Professional (64-bit and 32-bit)

Red Hat Enterprise Linux (RHEL) 5 Desktop/Workstation (64-bit)

Red Hat Enterprise Linux(RHEL) 6 Desktop/Workstation

SUSE Linux Enterprise Desktop 11 (64-bit)

HP qualified drivers may be preloaded or available from the HP support

Web site:

http://welcome.hp.com/country/us/en/support.html

SUSE Linux Enterprise drivers may also be obtained from: ftp://download.nvidia.com/novell or http://www.nvidia.com

Notes

1. Quadro K600 offered as CTO does not include a video cable

2. Quadro K600 offered as AMO includes one DP-to-DVI video cable adapter. Additional cables must be ordered separately.

adapter. Video cable adapters must be ordered separately.

3. Quadro K600 is Windows 8 Compliant.

Full height, half length (full-height bracket included)

AMD FirePro™ V3900 professional graphics

4. A total maximum of 2 active monitors are supported across all

display output types.

AMD FirePro V3900 **1GB Graphics**

Form Factor

Graphics Controller

Bus Type

Memory Connectors 1GB DDR3 memory

1 DL DVI, 1 DP output

One DP to DVI adapter included

PCI Express® x16, Generation 2.1

Maximum Resolution

Display Output

2560x1600 per display (5120x1600 max. horizontal resolution)

1 DisplayPort® 1.2 1 Dual-link DVI

Supported Graphics

APIs

OpenCL™ 1.1, DirectX® 11 and OpenGL 4.2

Available Graphics

Drivers

Genuine Windows® 7 Professional (64-bit and 32-bit) Genuine Windows Vista® Business (64-bit and 32-bit) Microsoft® Windows XP® Professional (64-bit and 32-bit)

Red Hat Enterprise Linux(RHEL)

SUSE Linux Enterprise Desktop 11 (64-bit and 32-bit)

HP qualified drivers may be preloaded or available from the HP support

Web site: http://welcome.hp.com/country/us/en/support.html

Power Consumption

Note

<50W

AMD Eyefinity technology can support multiple displays using a single enabled AMD FirePro™ professional graphics card; the number of supported displays varies by card model. Microsoft® Windows® 7, Windows Vista®, or Linux® is required in order to support more than 2 displays. Depending on the card model, native DisplayPort™ connectors

Technical Specifications - Graphics

and/or certified DisplayPort[™] active or passive adapters to convert your monitor's native input to your card's DisplayPort[™] or Mini-DisplayPort[™] connector(s) may be required. See www.amd.com/firepro for details.

NVIDIA Quadro K2000 Form Factor

2GB Graphics

Factor 4.38" H x 7.97" L

Single Slot, Full Height

Graphics Controller

NVIDIA Quadro K2000 Graphics Card

Kepler GK107 GPU 384 CUDA cores

Max Power: 51.1 Watts

Bus Type

PCI Express 2.0 x16

Memory 2 GB GDDR5, 2000 Mhz 128-bit memory I/O path

64 GB/s memory bandwidth

Connectors

1 DL-DVI(I) output, 2 DisplayPort outputs CTO: No video cable adapter included

AMO: One DP-to-DVI adapter included with card

Additional DVI-to-VGA, DisplayPort-to-VGA or DisplayPort-to-DVI

adapters are available as accessories

Maximum Resolution

DisplayPort:

- up to 3840 x 2160 x 30 bpp @ 60Hz

- supports High Bit Rate 2 (HBR2) and Multi-Stream Transport (MST)

DL-DVI(I) output:

- up to 2560 x 1600 x 32 bpp @ 60Hz

Image Quality Features

• 10-bit internal display processing pipeline

• 10-bit scan-out support

Display Output

VGA:

- requires use of DVI-to-VGA and/or DP-to-VGA video cable adapters

400 Mhz integrated RAMDAC

- Max resolution: 2048 x 1536 x 32 bpp @ 85 Hz

DL-DVI(I):

- Max resolution: 2560 x 1600 x 32 bpp @ 60 Hz

SL-DVI(I):

- Max resolution: 1920 x 1200 x 32 bpp @ 60 Hz

DisplayPort:

- Supports HBR2 and MST

- Max resolution: 3840 x 2160 x 30 bpp @ 60 Hz (only one monitor can be connected to a Quadro K2000 DisplayPort connector at this

resolution)

- Max number of DisplayPort daisy-chained monitors or hub connected monitors from a single Quadro K2000 DisplayPort connector: 4 with

maximum resolution of 1920 x 1200

Maximum number of monitors across all available Quadro K2000

outputs is 4.

Shading Architecture Full Microsoft DirectX 11 Shader Model 5



Technical Specifications - Graphics

Supported Graphics

APIs

OpenGL 4.3 DirectX 11

API support includes:

CUDA C, CUDA C++, DirectCompute 5.0, OpenCL, Java, Python, and

Fortran

Available Graphics

Drivers

Windows 8 Pro 64-bit Windows 8 (China) 64-bit

Genuine Windows 7 Professional (64-bit and 32-bit)

Red Hat Enterprise Linux (RHEL) 5 Desktop/Workstation (64-bit)

Red Hat Enterprise Linux(RHEL) 6 Desktop/Workstation

SUSE Linux Enterprise Desktop 11 (64-bit)

HP qualified drivers may be preloaded or available from the HP support

Web site:

http://welcome.hp.com/country/us/en/support.html

SUSE Linux Enterprise drivers may also be obtained from: ftp://download.nvidia.com/novell or http://www.nvidia.com

Notes

1. Quadro K2000 offered as CTO does not include a video cable adapter. Video cable adapters must be ordered separately.

2. Quadro K2000 offered as AMO includes one DP-to-DVI video cable adapter. Additional cables must be ordered separately.

NVIDIA Quadro K4000 Form Factor

3GB Graphics

Form Factor 4.376" H x 9.5" L

Single Slot, Full Height

Graphics Controller

NVIDIA Quadro K4000 Graphics Card

Kepler GK106 GPU 768 CUDA cores Max Power: 80 Watts PCI Express 2.0 x16

Bus Type Memory

3 GB GDDR5, 2800 Mhz 192-bit memory I/O path 134 GB/s memory bandwidth

Connectors

1 DL-DVI(I) output, 2 DisplayPort outputs CTO: No video cable adapter included

AMO: One DP-to-DVI adapter included with card

Additional DVI-to-VGA, DisplayPort-to-VGA or DisplayPort-to-DVI

adapters are available as accessories

Maximum Resolution

DisplayPort:

- up to 3840 x 2160 x 30 bpp @ 60Hz

supports High Bit Rate 2 (HBR2) and Multi-Stream Transport (MST)

DL-DVI(I) output:

up to 2560 x 1600 x 32 bpp @ 60Hz

Image Quality Features

10-bit internal display processing pipeline

10-bit scan-out support

Display Output VGA:

- requires use of DVI-to-VGA and/or DP-to-VGA video cable adapters

- 400 Mhz integrated RAMDAC

- Max resolution: 2048 x 1536 x 32 bpp @ 85 Hz

Technical Specifications - Graphics

DL-DVI(I):

- Max resolution: 2560 x 1600 x 32 bpp @ 60 Hz

SL-DVI(I):

Max resolution: 1920 x 1200 x 32 bpp @ 60 Hz

DisplayPort:

- Supports HBR2 and MST

- Max resolution: 3840 x 2160 x 30 bpp @ 60 Hz (only one monitor can be connected to a Quadro K4000 DisplayPort connector at this resolution)

- Max number of DisplayPort daisy-chained monitors or hub connected monitors from a single Quadro K4000 DisplayPort connector: 4 with maximum resolution of 1920 x 1200

HDMI:

- Requires use of DP-to-HDMI cable

Max Resolution: 1920 x 1080 x 32 bpp @ 60Hz

Maximum number of monitors across all available Quadro K4000 outputs is 4.

Shading Architecture

Full Microsoft DirectX 11 Shader Model 5.0 OpenGL 4.3

Supported Graphics

DirectX 11

APIs

Notes

API support includes:

CUDA C, CUDA C++, DirectCompute 5.0, OpenCL, Java, Python, and

Fortran

Available Graphics Drivers

Windows 8 Pro 64-bit Windows 8 (China) 64-bit

Genuine Windows 7 Professional (64-bit and 32-bit)

Red Hat Enterprise Linux (RHEL) 5 Desktop/Workstation (64-bit)

Red Hat Enterprise Linux(RHEL) 6 Desktop/Workstation

SUSE Linux Enterprise Desktop 11 (64-bit)

HP qualified drivers may be preloaded or available from the HP support Web site:

http://welcome.hp.com/country/us/en/support.html

SUSE Linux Enterprise drivers may also be obtained from:

ftp://download.nvidia.com/novell or http://www.nvidia.com

1. Quadro K4000 offered as CTO does not include a video cable adapter. Video cable adapters must be ordered separately.

- Quadro K4000 offered as AMO includes one DP-to-DVI video cable adapter. Additional cables must be ordered separately.
- 3. Quadro K4000 is Windows 8 Compliant.
- 4. A total maximum of 4 active monitors are supported across all display output types. To get 4 monitors, at least one monitor must be daisy chained on a DisplayPort output.
- 5. A DisplayPort hub device may be used to connect multiple DisplayPort monitors to a single Quadro K4000 DisplayPort output.

NVIDIA Quadro K5000 Form Factor

4.376" H x 10.5" L



Technical Specifications - Graphics

4GB Graphics

Dual Slot

Graphics Controller

NVIDIA Quadro K5000 Graphics Card based on the GK104 GPU

Bus Type

PCI Express 2.0 x16

Memory

4GB GDDR5 173GB/s memory bandwidth

Connectors

DVI-I (1), DVI-D (1), DP (2), Optional 3D Stereo bracket with 3-pin mini-

DIN connector.

No adapter included with card.

DVI to VGA, DisplayPort to VGA, DisplayPort to DVI, and DisplayPort to

Dual-Link DVI adapters available as accessories

Image Quality Features

DisplayPort with Multi-Stream Technology (MST) and High Bit

Rate 2 (HBR2), HDMI 1.4, and HDCP support

NVIDIA 3D Vision™ technology

Display Output

400 MHz integrated RAMDAC

 Maximum resolution over VGA (through DVI to VGA cable): 2048 × 1536 × 32 bpp at 85 Hz

Dual-link internal TMDS (DVI 1.0)

 Maximum resolution over digital port (single GPU and SLI mode): 2560 × 1600 × 32 bpp at 60 Hz (reduced blanking)

Single-link internal TMDS (DVI 1.0)

 Maximum resolution over digital port (single GPU and SLI mode):1920 × 1200 × 32 bpp at 60 Hz (reduced blanking)

DisplayPort with MST and HBR2.

Maximum resolution: 3840 × 2160 × 36 bpp at 60Hz

HDMI

Maximum resolution: 1920 × 1080 × 32 bpp at 60Hz

Supported Graphics **APIs**

OpenGL 4.2

DirectX 11 Shader model 5.0 Support

API support for NVIDIA's CUDA™ C, CUDA C++, DirectCompute 5.0,

OpenCL, Java, Python, Fortran

Available Graphics

Drivers

Genuine Windows 7 Professional (64-bit and 32-bit) Genuine Windows Vista Business (64-bit and 32-bit) Microsoft Windows XP Professional (64-bit and 32-bit)

Red Hat Enterprise Linux (RHEL) 5 Desktop/Workstation (64-bit and 32-

Red Hat Enterprise Linux (RHEL) 6 Desktop/Workstation SUSE Linux Enterprise Desktop 11 (64-bit and 32-bit)

HP qualified drivers may be preloaded or available from the HP support

Web site:

http://welcome.hp.com/country/us/en/support.html

Power Consumption

122 Watts

Note

No display output adapter included.



Technical Specifications - Graphics

AMD FirePro W7000 4GB Form Factor

Graphics

Full height, full length, single slot

Graphics Controller AMD FirePro™ W7000 Professional Graphics

Max Power: <150 Watts

PCI Express™ x16, Generation 3.0 **Bus Type**

4GB GDDR5, 153.6 GB/s bandwidth, ECC support Memory Connectors 4 x DisplayPort with HBR2 and MST support.

Maximum Resolution DisplayPort: 4096x2160 @24bpp 60Hz

> Dual Link DVI: 2560x1600 (requires DP to DL-DVI adapter) Single Link DVI: 1920x1200 (requires DP to DVI adapter)

VGA: 1920x1200 (requires DP to VGA adapter)

Image Quality Features Advanced support for 8-bit, 10-bit, and 16-bit per RGB color component

Display Output Max number of monitors supported using DisplayPort: 6

> Monitor chaining from a single DisplayPort options(subject to a max of 6 total monitors across all outputs, requires use of DisplayPort Monitors supporting

MST or the use of DisplayPort hubs):

1 4096x2169 display

2 2560x1600 displays

4 1920x1200 displays

Shading Architecture

Supported Graphics

APIs

Shader Model 5.0

OpenGL® 4.2 with OpenGL Shading Language

OpenCL 1.1

Microsoft® DirectX® 11.1

Available Graphics

Drivers

Windows 8

Windows 7 Professional (64-bit and 32-bit)

Windows 8 (64bit and 32-bit) Red Hat Enterprise Linux(RHEL)

SUSE Linux Enterprise Desktop 11 (64-bit and 32-bit)

HP qualified drivers may be preloaded or available from the HP support Web

site:

http://welcome.hp.com/country/us/en/support.html

Note

1. AMD Eyefinity technology can support multiple displays using a single enabled AMD FirePro™ professional graphics card; the number of

supported displays varies by card model. Microsoft® Windows® 7, Windows Vista®, or Linux® is required in order to support more than 2 displays.

Depending on the card model, native DisplayPort™ connectors and/or certified DisplayPort™ active or passive adapters to convert your monitor's native input to your card's DisplayPort™ or Mini-DisplayPort™ connector(s)

may be required. See www.amd.com/firepro for details.

2. Factory configured FirePro W7000 graphics card does not include any

video adapter cables. Adapters must be ordered separately.

3. Option Kit FirePro W7000 graphics card does not include any video cable

adapters. Adapters must be ordered seperately.

NVIDIA Quadro K6000 Form Factor 12GB Graphics

4.376" H x 10.5" L

Dual Slot

Power: 234 Watts Weight: ~880 grams



Technical Specifications - Graphics

Graphics Controller NVIDIA Quadro K6000 Graphics Card based on the GK180 GPU

Core Count: 2880 Base Clock: 797 MHz Boost Clock: 902 MHz

Bus Type PCI Express 3.0 x16

Memory 12GB GDDR5

384-bit memory I/O path 288 GB/s memory bandwidth

ECC Memory

Connectors DVI-I (1), DVI-D (1), DP (2), Optional 3D Stereo bracket with 3-pin mini-

DIN connector.

Factory configured option: No adapter included with card.

Option Kit: No adaptor included with card.

DVI to VGA, DisplayPort to VGA, DisplayPort to DVI, and DisplayPort to

Dual-Link DVI adapters available as accessories.

Maximum Resolution Dual DisplayPort (up to 2560 x 1600 @ 60Hz and 1920x1200 @ 120Hz)

Dual-link DVI-I output (up to 2560 x 1600 @ 60Hz and 1920x1200 @

120Hz)

Image Quality Features

 DisplayPort with Multi-Stream Technology (MST) and High Bit Rate 2 (HBR2), HDMI 1.4, and HDCP support

NVIDIA 3D Vision™ technology

NVIDIA Premium Mosaic and nView

Display Output

400 MHz integrated RAMDAC

Maximum resolution over VGA (through DVI to VGA cable): 2048
 × 1536 × 32 bpp at 85 Hz

Dual-link internal TMDS (DVI 1.0)

Maximum resolution over digital port (single GPU and SLI mode):
 2560 × 1600 × 32 bpp at 60 Hz (reduced blanking)

Single-link internal TMDS (DVI 1.0)

 Maximum resolution over digital port (single GPU and SLI mode):1920 × 1200 × 32 bpp at 60 Hz (reduced blanking)

DisplayPort with MST and HBR2.

Maximum resolution: 3840 × 2160 × 36 bpp at 60Hz

HDMI

Maximum resolution: 1920 × 1080 × 32 bpp at 60Hz

Shading Architecture Shader Model 5.0

Full IEEE 764-2008 32-bit and 64-bit precision

Supported Graphics

APIs

Full OpenGL 4.3 Full DirectX 11

CUDA API support includes:

CUDA C, CUDA C++, DirectCompute 5.0, OpenCL, Java, Python, and

Fortran

Available Graphics

Drivers

Windows 8

Windows 7 Professional (64-bit and 32-bit)

Technical Specifications - Graphics

Red Hat Enterprise Linux (RHEL) 6 Desktop/Workstation SUSE Linux Enterprise Desktop 11 (64-bit and 32-bit)

HP qualified drivers may be preloaded or available from the HP support Web site:

http://welcome.hp.com/country/us/en/support.html

Novell SUSE Linux Enterprise drivers may also be obtained from: ftp://download.nvidia.com/novell or http://www.nvidia.com

1. NVIDIA GRID VGX Pass Through feature supported on NVIDIA Quadro K6000 to enable direct mapping of GPU to Virtual Machine.

2. No display output adapter included.

Notes



Technical Specifications - High Performance GPU Computing

NVIDIA Tesla K20c Compute Processor **Form Factor** 4.376 inches by 10.5 inches

Dual Slot

PCI Express Gen2 ×16 System Interface

Video Outputs None.

Memory 5GB GDDR5, 320-bit memory path

Peak Memory Bandwidth

208 GB/s (with ECC off)

Supported APIs CUDA and OpenACC API support includes: CUDA C, CUDA C++, Java, Python, and Fortran

Supported Operating

Windows 8 (64-bit)

Systems Genuine Windows 7 Professional (64-bit)

Red Hat Enterprise Linux (RHEL) 5, 6 Desktop/Workstation (64-bit)

SUSE Linux Enterprise Desktop 11 (64-bit)

HP qualified drivers may be preloaded or available from the HP support

Web site:

http://welcome.hp.com/country/us/en/support.html

Novell SUSE Linux Enterprise drivers may also be obtained from:

ftp://download.nvidia.com/novell or http://www.nvidia.com

Processor Cores GK110 GPU, 706 MHz clock

2496 CUDA cores

Power Consumption ~225 Watts

NOTE 1: A 1125W PSU is required for any K20 configuration on the

Z820

NVIDIA Tesla K40 Compute Processor **Form Factor** Size: 4.376 inches by 10.5 inches

Slots: Dual Slot

Power Connectors: One 6-pin and one 8-pin

Weight: ~826 grams PCI Express Gen3 ×16

Video Outputs None.

12GB GDDR5. Memory

> memory path: 384-bit memory clock: 3Ghz

Peak Memory Bandwidth

System Interface

288 GB/s

Supported APIs CUDA, OpenACC, OpenCL 1.2 API support includes:

C, C++, Java, Python, and Fortran

Supported Operating

Systems

Windows 8 (64-bit)

Genuine Windows 7 Professional (64-bit)

Red Hat Enterprise Linux (RHEL) 5, 6 Desktop/Workstation (64-bit)

SUSE Linux Enterprise Desktop 11 (64-bit)

HP qualified drivers may be preloaded or available from the HP support

Web site:

http://welcome.hp.com/country/us/en/support.html

Novell SUSE Linux Enterprise drivers may also be obtained from:

ftp://download.nvidia.com/novell or http://www.nvidia.com

Technical Specifications - High Performance GPU Computing

Processor Cores GK110B GPU

Base Clock: 745 MHz Boost Clock: up to 875 Mhz

2888 CUDA cores

Power Consumption ~235 Watts

Note 1: A 1125W PSU is required for any K40 configuration on the

Z820

Tesla K40 GPU Boost By default the Tesla K40 active ships with the core clock set to the base

clock. HPC workloads can have one or more characteristics as described. When selecting one of the supported boost clocks a good strategy is to characterize the workload with the available boost clocks. For example, DGEMM/Linpack are extremely demanding on power. Therefore, the "base clock" may be the correct choice when running Linpack. Some workloads in life sciences, manufacturing, CFD, CAD, etc., may have power headroom and can take advantage of one of the

boost clocks.



Technical Specifications - Multimedia and Audio Devices

HP Thin USB Powered Frequency Response (- FO to 20kHz

Speakers 3dB, 24-bit/96kHz input)

Dimensions Speakers: 14.52 x 9.50 x 2.45 cm (5.72 x 3.74 x 0.96 in) per speaker



Technical Specifications - Optical and Removable Storage

HP DVD-ROM Drive

Description 5.25-inch, half-height, tray-load

Mounting Orientation Either horizontal or vertical

Interface Type SATA/ATAPI

Dimensions (WxHxD) 15.0 x 4.4 x 20.3 cm (5.9 x 1.7 x 8.0 in)

Disc Capacity DVD-ROM Single layer: Up to 4.7 GB Double layer: Up to

8.5 GB

Access Times DVD-ROM Single Layer < 140 ms (typical)

> **CD-ROM Mode 1** < 125 ms (typical) **Full Stroke DVD** < 250 ms (seek) **Full Stroke CD** < 210 ms (seek)

Source SATA DC power receptacle **Power**

> **DC Power** 5 VDC ± 5%-100 mV ripple p-p 12 VDC ± 5%-200 mV ripple p-p Requirements

DC Current 5 VDC - <1000 mA typical, < 1600 mA

maximum

12 VDC - < 600 mA typical, < 1400 mA

maximum

Operating Environmental (all

conditions noncondensing)

Temperature

Relative Humidity

Maximum Wet Bulb

Temperature

Operating Systems Supported

10% to 90%

86° F (30° C)

41° to 122° F (5° to 50° C)

Windows 7 Professional 32-bit and 64-bit. Windows Vista Business 64*, Windows Vista Business 32*, Windows Vista Home Basic

32*, Windows 2000, Windows XP Professional or Windows XP Home 32*. Red Hat Enterprise Linux(RHEL) WS4**, 5, 6

Desktop/Workstation,

Removed reference to "Novell" because of acquisition and changed product reference to "SUSE Linux Enterprise Desktop 10 & 11", No driver is required for this device. Native support is provided by the operating system.

HP DVD+/-RW Drive

Description 5.25-inch, half-height, tray-load

Mounting Orientation Either horizontal or vertical

Interface Type SATA/ATAPI

Dimensions (WxHxD) 15.0 x 4.4 x 17.5 cm (5.9 x 1.7 x 8.0 in)

Disc Formats DVD-RAM DVD+R

DVD+RW DVD+R DL DVD-R DL DVD-R **DVD-RW** CD-R CD-RW



Technical Specifications - Optical and Removable Storage

Disc Capacity

DVD-ROM

Full Stroke DVD

Full Stroke CD

CD ROM Read

CD-ROM, CD-R Up to 40X

CD-RW Up to 32X

CD-RW Up to 32X

DVD ROM Read DVD-RAM Up to 12X
DVD+RW Up to 8X
DVD-RW Up to 8X

DVD+R DL Up to 12X
DVD-R DL Up to 12X
DVD-ROM Up to 16X
DVD-ROM DL Up to 16X
DVD+R Up to 16X
DVD+R Up to 16X
DVD-R Up to 16X

Power Source SATA DC power receptacle

DC Power 5 VDC ± 5%-100 mV ripple p-p

Requirements 12 VDC \pm 5%-200 mV ripple p-p **DC Current** 5 VDC -<1000 mA typical, <1600 mA

maximum

12 VDC -<1200 mA typical, <2000 mA

maximum

Operating Temperature 41° to 122° F (5° to 50° C)
Environmental (all Polative Humidity 10% to 90%

conditions noncondensing)

Relative Humidity
10% to 90%
86° F (30° C)
Temperature

> Operating Systems Supported

Windows 8 32-bit and 64-bit, Windows 7

Professional 32-bit and 64-bit,

Windows Vista Business 64*, Windows Vista Business 32*, Windows Vista Home Basic

32*, Windows 2000, Windows XP Professional or Windows XP Home 32*. Red Hat Enterprise Linux(RHEL) WS4**, 5, 6

Desktop/Workstation

SUSE Linux Enterprise Desktop 10 & 11

No driver is required for this device. Native support is provided by the operating system. HP SATA SuperMulti DVD Writer Drive, Roxio

Kit Contents HP SATA SuperMulti DVD Writer Drive, Roxio

Easy Media Creator software, Intervideo WinDVD Software, installation guide, and

DVD+R media.

HP Blu-Ray Writer Description 5.25-inch, half-height, tray-load

Mounting Orientation Either horizontal or vertical

Interface Type SATA

Dimensions (WxHxD) 15.0 x 4.4 x 20.3 cm (5.9 x 1.7 x 8.0 in)

Disc Formats BD-ROM

BD-R BD-RE



Technical Specifications - Optical and Removable Storage

DVD-RAM DVD+R DVD+RW DVD+R DL DVD-R DL DVD-R **DVD-RW** CD-R CD-RW **Disc Capacity DVD-ROM** 8.5 GB DL or 4.7 GB standard 50 GB DL or 25 GB standard Blu-ray **Full Stroke DVD** < 250 ms (seek) **Full Stroke CD** < 210 ms (seek) Blu-ray <275 ms (seek) Startup Time (Time to BD-ROM (SL/DL) 25S / 28S drive ready from tray BD-R (SL/DL) 25S / 28S loading) BD-RE (SL/DL) 25S / 28S DVD-ROM (SL/DL) 18S / 18S 25S / 25S DVD-R (SL/DL) **DVD-RW** 25S DVD+R (SL/DL) 25S / 25S **DVD+RW 25S DVD-RAM** 45S CD-ROM 45S **Maximum Data CD ROM Read** CD-ROM Up to 40X **Transfer Rates** Up to 40X CD-R CD-RW Up to 40X **DVD ROM Read DVD-RAM** Up to 5X **DVD+RW** Up to 10X **DVD-RW** Up to 10X DVD+R DL Up to 8X DVD-R DL Up to 8X **DVD-ROM** Up to 16X DVD-ROM DL Up to 8X DVD+R Up to 12X DVD-R Up to 12X Blu-Ray **BD-ROM** Up to 6X **BD-ROM DL** Up to 4.8X BD-R Up to 6X BD-R DL Up to 4.8X BD-R Up to 6X **BD-RE SL/DL** Up to 4.8X **Power** Source SATA DC power receptacle **DC Power** 5 VDC ± 5%-100 mV ripple p-p



Requirements DC Current

12 VDC ± 10%-100 mV ripple p-p

5 VDC -900 mA typical, 1200 mA maximum 12 VDC -1000 mA typical, 1600 mA maximum

Technical Specifications - Optical and Removable Storage

Operating Environmental (all conditions noncondensing) Temperature
Relative Humidity
Maximum Wet Bulb
Temperature

Operating Systems

Supported

41° to 122° F (5° to 50° C)

15% to 80% 86° F (30° C)

Windows 7 Professional 32-bit and 64-bit, Windows Vista Business 64*, Windows Vista Business 32*, Windows Vista Home Basic

32*, Windows 2000, Windows XP Professional or Windows XP Home 32*. Red Hat Enterprise Linux(RHEL) WS4**, 5, 6

Desktop/Workstation,

SUSE Linux Enterprise Desktop 10 & 11

* No driver is required for this device. Native support is provided by the operating system.

** RHEL WS4 not supported on Z200/Z200SFF

Kit Contents HP Blue Laser RW Drive, Roxio Easy Media

Creator software, Intervideo WinDVD

Software, installation guide.

Disclaimer As Blu-Ray is a new format containing new technologies, certain disc,

digital connection, compatibility and/or performance issues may arise, and do not constitute defects in the product. Flawless playback on all systems is not guaranteed. In order for some Blu-Ray titles to play, they may require a DVI or HDMI digital connection and your display may require HDCP support. HD-DVD movies cannot be played on this

workstation.

HP DX115 Removable Interface Type
Drive Enclosure
Dimensions (M)

Dimensions (WxHxL)

Weight

Compatible with SAS or SATA controllers

147.6 x 41.1 x 205 mm (5.81 x 1.62 x 8.08 in)

Frame and Carrier: 1.73 kg (3.8 lbs)

Carrier: 0.45 kg (1 lbs)

Technical Specifications - Controller Cards

HP IEEE 1394b FireWire PCle Card **Data Transfer Rate** Supports up to 800 Mbps **Devices Supported** IEEE-1394 compliant devices

Bus Type PCIe card full height PCIe slots

Ports Two IEEE-1394b bilingual 9-Pin connectors (Rear)

Internal Connectors One 10-Pin Header connector

System Requirements Windows 7 Professional 32-bit and 64-bit, Microsoft® Windows® XP

> Professional, Windows XP Home, Windows Vista, SLED 11 and RHEL 6. Intel Pentium® G series or higher processor, 128-MB RAM, 1-GB Hard Drive, CD-ROM drive, built in sound system, Available PCle slot.

Temperature -Operating

50° to 131° F (10° to 55° C)

Temperature – Storage –22° to 140° F (–30° to 60° C)

Relative Humidity -

20% to 80% Operating

Compliances FCC Part 15B, cULus 60950, CE Mark EN55022B(1995)/EN55024-

1998 STD, Taiwan BSMI CNS13438, Korea MIC

Operating Systems

Supported

Windows 7 Professional 32-bit and 64-bit, Windows Vista® Business 32-bit and 64-bit, Windows® XP Professional, XP Professional 64-bit,

RHEL 6 and SLED 11.

HP Thunderbolt-2 PCIe 1-port I/O Card

Data Transfer Rate

Supports up to 20 Gb/s (20,000 Mb/s)

Devices Supported

Thunderbolt™ certified devices

Bus Type

PCIe card, full or half height PCIe slots

Ports

One Thunderbolt™ 2 external 20-Pin output connectors (Rear)

Internal Connectors

One 5-Pin header connector

System Requirements

Genuine Windows 7 Professional 64-bit, Genuine Windows 8.1 64-bit, Intel i5 series or higher processor, 128-MB RAM, 1-GB Hard Drive, available

PCIe slot.

Temperature - Operating 50° to 131° F (10° to 55° C) -22° to 140° F (-30° to 60° C) Temperature - Storage

Relative Humidity -

20% to 80%

Operating

Compliances

FCC Part 15B, cULus 60950, CE Mark EN55022B(1995)/EN55024-1998

STD, Taiwan BSMI CNS13438, Korea MIC

Operating Systems

Supported

Genuine Windows 7 Professional 64-bit, Genuine Windows 8.1 64-bit.

Kit Contents

HP Thunderbolt™ 2 PCIe 1-port I/O Card, full height and half height bracket,

DisplayPort to DisplayPort cable, internal header cables(2), user

documentation and warranty card.

The HP Thunderbolt™ 2 PCIe 1-port I/O Card has a one-year Limited Warranty

Warranty or the remainder of the warranty of the HP supported product in which it is installed. Technical support is available seven days a week, 24 hours a day, by phone, as well as online support forums. Certain restrictions

and exclusions apply.

Technical Specifications - Networking and Communications

Integrated Intel 82579LM PCIe GbE Controller Connector RJ-45

Controller Intel 82579LM GbE platform LAN connect networking controller

Memory 24 KB FIFO packet buffer memory

Data Rates Supported 10/100/1000 Mbps

Compliance 802.1P, 802.1Q, 802.2, 802.3, 802.3ab, 802.3az, 802.3u

Bus Architecture PCI Express and SMBus

Data Transfer Mode PCIe-based interface for active state operation (S0 state) and SMBus

for host and management traffic (Sx low power state)

Power Requirement Requires 3.3V and 1.05V or just 3.3V with integrated regulators

Boot ROM Support Yes

Network Transfer Mode Full-duplex; Half-duplex (not supported for the 1000BASE-T transceiver)

Network Transfer Rate 10BASE-T (half-duplex) 10 Mbps

10BASE-T (full-duplex) 20 Mbps 100BASE-TX (half-duplex) 100 Mbps 100BASE-TX (full-duplex) 200 Mbps 1000BASE-T (full-duplex) 2000 Mbps

Management WOL, auto MDI crossover, PXE, Muti-port teaming, RSS, Advanced

Capabilities cable diagnostic.

AMT 7.0 support

Broadcom (5761) NetXtreme Gigabit Ethernet Plus NIC Connector RJ-45

Controller Broadcom 5761 PCI-Express LAN Controller

Memory 8 MB NVRAM serial Flash

Data Rates Supported 10/100/1000 Mbps

Compliance IEEE 802.1P, 802.1Q, 802.2, 802.3, 802.3AB, 802.3u, and 802.3x

Bus Architecture PCI-Express

Data Path Width Single Channel PCI-Express

Data Transfer Mode Bus Master DMA

Hardware FCC class B, Canada and US NRTL Mark, C-Tick for Australia, BSMI **Certifications** for Taiwan, VCCI for Japan, MIC for Korea, GOST for Russia, UL listed

(E212044), European Union Notice (CE 0682)

Power Requirement 1.8W @ 3.3V

Boot ROM Support Yes

Network Transfer Mode Full-duplex

Half-duplex (not available for the 1000BASE-T transceiver)

Network Transfer Rate 10BASE-T (half-duplex) 10 Mbps

10BASE-T (full-duplex) 20 Mbps 100BASE-TX (half-duplex) 100 Mbps 100BASE-TX (full-duplex) 200 Mbps 1000BASE-T (full-duplex) 2000 Mbps

Operating Temperature 32° to 131°F (0° to 55° C)

Operating Humidity 131° F (55° C) with 5% to 95% non-condensing humidity **Dimensions** 7 cm x 10.5 cm (2.75 in x 4.13 in), low profile compatible

Operating System Driver Support

Windows 7 Professional 32-bit and 64-bit, Windows Vista 32-bit SP1, Windows Vista x64 SP1, Windows XP 32 bit professional, Windows XP

x64

Red Hat Enterprise Linux (RHEL) 5, 6; Novell SLED 10 & 11



Technical Specifications - Networking and Communications

Management ACPI, WOL and DMI 2.0, PXE 2.0, WfM 2.0, Broadcom mgmt utility,

Capabilities ASF2.0, DASH 1.0 and DASH 1.1 profiles

Kit Contents Broadcom NetXtreme Gigabit Ethernet Plus NIC, Broadcom NetXtreme

Gigabit Ethernet Plus NIC USB Cable Assembly, CD, drivers, quick

install guide, product warranty statement

Intel Gigabit CT Desktop NIC **Connector** RJ-45

Controller Intel WG82574L Gigabit Ethernet Controller

Memory Integrated Dual 48K configurable transmit receive FIFO Buffers

Data Rates Supported 10/100/1000 Mbps

Compliance IEEE 802.1P, 802,1Q, 802.2, 802.3, 802.3AB and 802.3u compliant,

802.3x flow control

Bus Architecture PCI-E 1.0a

Data Path Width X1, 250 MB/s, Bi-directional interface

Data Transfer Mode Bus-master DMA

Hardware FCC, B, CE, TUV- cTUVus Mark Canada and United States, TUV- GS

Certifications Mark for European Union

Power Requirement Aux 3.3V, 3.0 Watts in 1000base-T and 2.0 Watts in 100Base-T

Boot ROM Support Yes

Network Transfer Rate 10BASE-T (half-duplex) 10 Mbps

10BASE-T (full-duplex) 20 Mbps 100BASE-TX (half-duplex) 100 Mbps 100BASE-TX (full-duplex) 200 Mbps 1000BASE-T (full-duplex) 2000 Mbps

Operating Temperature 32° to 131°F (0° to 55° C)
Operating Humidity 85% at 131° F (55° C)

Dimensions 12.1 x 5.7 x 2.0 cm (4.75 x 2.25 x 0.8 in)

Operating System Driver Support

Windows 7 Professional 32-bit and 64-bit, Windows Vista Business 64, Windows Vista Business 32, Windows XP Professional, Windows XP

x64.

Red Hat Enterprise Linux 4 (RHEL4.8 or newer)*, Red Hat Enterprise Linux 5 (RHEL5.3 or newer), Red Hat Enterprise Linux 6, SUSE Linux

Enterprise Desktop (SLED) 11

RHEL 4 and 5, SLED 10, are not supported on the Z220 CMT/SFF

Management Capabilities WOL, PXE, DMI, WFM 2.0

Kit Contents Intel Gigabit CT Desktop NIC, low profile bracket, CD containing Intel

PROset II NIC drivers, quick install guide, product warranty statement

HP X520 10GbE Dual Port Adapter

Hardware Certifications

FCC B, UL, CE, VCCI, BSMI, CTICK, KCC

Technical Specifications - Networking and Communications

HP 10GbE SFP+ SR

Transceiver

Operating Temperature0°C to 45°C (32°F to 113°F) **Operating Humidity** 0% to 85%, noncondensing **Dimensions** (H x W x D) 0.47(h) x 0.54(w) x 2.19(d)inches

(1.19 x 1.38 x 5.57 cm)

HP 361T PCIe Dual PortConnector Two RJ-45

Gigabit NIC

Controller Intel® Ethernet I350 Controller

Data Rates Supported 10/100/1000 Mbps, Half- and full-duplex

Compliance 802.3, 802.3u, 802.3x, 802.3ab, 802.3ad, 802.1p, 802.1Q, 802.3az,

IEEE 1588

PCIe v2.0 standard RoHS (6 of 6)

FCC (U.S. only) Class B DOC (Canada) Class B

CE EN 55024, EN55022 Class B

VCCI Class II UL 1950 **CSA 950** EN 60950 CE

ACPI 1.1a

Microsoft WHQL (Windows Hardware Quality Labs)

Bus Architecture PCI-E 1.0a

Data Path Width Four lane (x4) PCI Express compatible with x4, x8, and x16 PCI

Express slots

Power Requirement 4.1W idle without EEE link partner

3.2W idle with EEE link partner

4.2W maximum

Network Transfer Rate 10BASE-T (half-duplex) 10 Mb/s

10BASE-T (full-duplex) 20 Mb/s 100BASE-TX (half-duplex) 100 Mb/s 100BASE-TX (full-duplex) 200 Mb/s 1000BASE-T (full-duplex) 2000 Mb/s

Operating Temperature 32° to 131°F (0° to 55° C)

Operating Humidity 10% to 95% non-condensing

Dimensions (H x W x D) 5.3 x 2.5 in (13.50 cm x 6.4 cm) (without brackets)

Operating System

Windows 7 Professional 32-bit and 64-bit.

Driver Support

Red Hat Enterprise Linux(RHEL) WS4, 5, 6 Desktop/Workstation

Novell SLED 10 & SLED 11

Management **Capabilities**

WOL, PXE 2.1

Kit Contents

HP 361T PCIe Dual Port Gigabit NIC PCA with a standard height

bracket attached to it (the low profile bracket is included in the clamshell

that the PCA ships in)

Product Warranty statement and the Quick Install Card (QIC).



Technical Specifications - Networking and Communications

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